

2. Specification

2-1. Radio Frequency & Channel

1) LTE BAND frequency

Equa.	Freq. Range	CH Range
FUL = FUL_low+0.1(NUL-NOFFS-UL)	LB1 : 1920 ~ 1980	18000≤N≤18599
	LB3 : 1710 ~ 1785	19200≤N≤19949
	LB5 : 824 ~ 849	20400≤N≤20649
	LB7 : 2500 ~ 2570	20750≤N≤21449
	LB8 : 880 ~ 915	21450≤N≤21799
	LB20 : 832 ~ 862	24150≤N≤24449
	LB40 : 2300 ~ 2400	38650≤N≤39649
FDL = FDL_low+0.1(NDL-NOFFS-DL)	LB1 : 2110 ~ 2170	0≤N≤599
	LB3 : 1805 ~ 1880	1200≤N≤1949
	LB5 : 869 ~ 894	2400≤N≤2649
	LB7 : 2620 ~ 2690	2750≤N≤3449
	LB8 : 925 ~ 960	3450≤N≤3799
	LB20 : 791 ~ 821	6150≤N≤6449
	LB40 : 2300 ~ 2400	38650≤N≤39649

2) WCDMA BAND frequency

Equa.	Freq. Range	CH Range
Tx = N*0.2	WB1 : 1920 ~ 1980	9612≤N≤9888
	WB2 : 1850 ~ 1910	9262≤N≤9538
	WB4 : 1710 ~ 1755	1312≤N≤1513
	WB5 : 824 ~ 849	4132≤N≤4233
	WB8 : 880 ~ 915	2712≤N≤2863
Rx = N*0.2	WB1 : 2110 ~ 2170	10562≤N≤10838
	WB2 : 1930 ~ 1990	9662≤N≤9938
	WB4 : 2110 ~ 2155	1537≤N≤1738
	WB5 : 869 ~ 894	4357≤N≤4458
	WB8 : 925 ~ 960	2937≤N≤3088

3) GSM BAND frequency

Equa.	Freq. Range	CH Range
Tx = 824.2+0.2*(N-128)	GSM850 : 824 ~ 849	128≤N≤251
Tx = 890+0.2*(N-1024)	GSM900 : 880 ~ 915	975≤N≤1023
Tx = 1710.2+0.2*(N-512)	DCS : 1710 ~ 1785	512≤N≤885
Tx = 1850.2+0.2*(N-512)	PCS : 1850 ~ 1910	512≤N≤810
Rx = 869.2+0.2*(N-128)	GSM850 : 869 ~ 894	128≤N≤251
Rx = 935+0.2*(N-1024)	GSM900 : 925 ~ 960	975≤N≤1023
Rx = 1805.2+0.2*(N-512)	DCS : 1805 ~ 1880	512≤N≤885
Rx = 1930.2+0.2*(N-512)	PCS : 1930 ~ 1990	512≤N≤810

2. Specification

2-2. GSM / WCDMA / LTE General Specification

1) GSM BAND

		GSM 850	GSM 900	DCS1800	PCS1900
Freq. Band[MHz] Uplink/Downlink		824~849 869~894	880~915 925~960	1710~1785 1805~1880	1850~1910 1930~1990
ARFCN range		128~251	0~124 & 975~1023	512~885	512~810
Tx/Rx spacing		45 MHz	45 MHz	95 MHz	80 MHz
Mod. Bit rate/ Bit Period	GPRS	270.833 Kbps 3.692 us	270.833 Kbps 3.692 us	270.833 Kbps 3.692 us	270.833 Kbps 3.692 us
Time Slot Period/Frame Period		576.9 us 4.615 ms	576.9 us 4.615 ms	576.9 us 4.615 ms	576.9 us 4.615 ms
Modulation	GPRS	0.3 GMSK	0.3 GMSK	0.3 GMSK	0.3 GMSK
MS Power	GPRS	32.5 dBm~5 dBm	33.5 dBm~5 dBm	30.5 dBm~0 dBm	30 dBm~0 dBm
Power Level	GPRS	5 pcl~19 pcl	5 pcl~19 pcl	0 pcl~15 pcl	0 pcl~15 pcl
Sensitivity		-102 dBm	-102 dBm	-100 dBm	-102 dBm
TDMA Mux		8	8	8	8
Cell Radius		3 Km	3 Km	2 Km	2 Km

2. Specification

2) WCDMA BAND

	WCDMA BAND1	WCDMA BAND2	WCDMA BAND4	WCDMA BAND5	WCDMA BAND8
Freq. Band[MHz] Uplink/Downlink	1920~1980 2110~2170	1850~1910 1930~1990	1710~1755 2110~2155	824~849 869~894	880~915 925~960
ARFCN range	9612~9888 10562~10838	9262~9538 9662~9938	1312~1513 1537~1738	781~4233 1006~4458	2712~2863 2937~3088
Tx/Rx spacing	190MHz	80MHz	400MHz	45MHz	45MHz
Mod. Bit rate/ Bit Period	3.84 Mcps/s	3.84 Mcps/s	3.84 Mcps/s	3.84 Mcps/s	3.84 Mcps/s
Time Slot Period/Frame Period	10ms	10ms	10ms	10ms	10ms
Modulation	UL : HQPSK DL : QPSK	UL : HQPSK DL : QPSK	UL : HQPSK DL : QPSK	UL : HQPSK DL : QPSK	UL : HQPSK DL : QPSK
MS Power	Max:23.5dBm (+1~-3)dBm Min:<-50dBm	Max:23.5dBm (+1~-3)dBm Min:<-50dBm	Max:22.5dBm (+1~-3)dBm Min:<-50dBm	Max:24.0dBm (+1~-3)dBm Min:<-50dBm	Max:24.3dBm (+1~-3)dBm Min:<-50dBm
Power Level	Class3	Class3	Class3	Class3	Class3
Sensitivity	-106.7dBm	-104.7dBm	-104.7dBm	-104.7dBm	-104.7dBm
TDMA Mux	-	-	-	-	
Cell Radius	-	-	-	-	

2. Specification

3) LTE BAND

	LTE BAND1	LTE BAND3	LTE BAND5	LTE BAND7	LTE BAND8	LTE BAND20	LTE BAND40
Freq. Band[MHz] Uplink/Downlink	1920~1980 2110~2170	1710 ~ 1785 1805 ~ 1880	824~849 869~894	2500~2570 2620~2690	880~915 925~960	832~862 791~821	2300~2400 2300~2400
ARFCN range	18000~18599 0~599	19200 ~ 19949 1200~1949	20400~20649 2400~2649	20750~21449 2750~3449	21450~21799 3450~3799	19250 ~ 19950 1250~1950	38650~39649 38650~39649
Tx/Rx spacing	190 MHz	95 MHz	45 MHz	120 MHz	45 MHz	41 MHz	
Mod. Bit rate/ Bit Period	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)	9Mbps/s (at 10MHz BW,50RB)
Time Slot Period/Frame Period	10ms	10ms	10ms	10ms	10ms	10ms	10ms
Modulation	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM	UL : QPSK 16QAM 64QAM DL : QPSK 16QAM 64QAM 256QAM
MS Power	Max:23.5±2.7dBm Min:-49dBm	Max:23.5±2.7dBm Min:-49dBm	Max:24.5±2.7dBm Min:-49dBm	Max:23.5±2.7dBm Min:-49dBm	Max:24.3±2.7dBm Min:-49dBm	Max:24.5±2.7dBm Min:-49dBm	Max:23±2.7dBm Min:-49dBm
Power Level	Class3	Class3	Class3	Class3	Class3	Class3	Class3
Sensitivity	-97dBm	-94dBm	-95dBm	-95dBm	-94dBm	-94dBm	-97dBm
TDMA Mux	-	-		-	-	-	-
Cell Radius	-	-		-	-	-	-

2. Specification

2-3. GSM BAND TX power control level

TX Power control level	GSM850	GSM900
5	33±2 dBm	33±2 dBm
6	31±3 dBm	31±3 dBm
7	29±3 dBm	29±3 dBm
8	27±3 dBm	27±3 dBm
9	25±3 dBm	25±3 dBm
10	23±3 dBm	23±3 dBm
11	21±3 dBm	21±3 dBm
12	19±3 dBm	19±3 dBm
13	17±3 dBm	17±3 dBm
14	15±3 dBm	15±3 dBm
15	13±3 dBm	13±3 dBm
16	11±5 dBm	11±5 dBm
17	9±5 dBm	9±5 dBm
18	7±5 dBm	7±5 dBm
19	5±5 dBm	5±5 dBm
-	-	-

TX Power control level	DCS1800
0	30±2 dBm
1	28±3 dBm
2	26±3 dBm
3	24±3 dBm
4	22±3 dBm
5	20±3 dBm
6	18±3 dBm
7	16±3 dBm
8	14±3 dBm
9	12±4 dBm
10	10±4 dBm
11	8±4 dBm
12	6±4 dBm
13	4±4 dBm
14	2±5 dBm
15	0±5 dBm

TX Power control level	PCS1900
0	30±2 dBm
1	28±3 dBm
2	26±3 dBm
3	24±3 dBm
4	22±3 dBm
5	20±3 dBm
6	18±3 dBm
7	16±3 dBm
8	14±3 dBm
9	12±4 dBm
10	10±4 dBm
11	8±4 dBm
12	6±4 dBm
13	4±4 dBm
14	2±5 dBm
15	0±5 dBm

3. Operation Instruction and Installation

Main Function

Item	Description
OS	Android V7.0.1 (Nougat)
RF	LTE Cat.6 (300/ 50Mbps)
Battery	3,600mAh
Base Band	Exynos7870 1.6GHz (Octa-Core)
Other RF	A-GPS, Glonass, BT4.1, USB 2.0, NFC, WIFI 802.11 a/b/g/n/ac 2.4+5GHz, MST
Camera	13M+13M Camera
LCD	5.5" FHD OCTA
RAM	3GB RAM + 16GB eMMC
Sensor	Accelerometer, Fingerprint Sensor, Gyro Sensor, Geomagnetic Sensor, Light Sensor, Proximity Sensor, RGB Sensor
Accessory	Charger: 5V/1.55A Data cable : 0.8M USB-A Ear phone: 3.5pi, 4pin Ejection Pin

9. Reference Abbreviate

Reference Abbreviate

- **AAC**: Advanced Audio Coding.
- **AVC** : Advanced Video Coding.
- **BER** : Bit Error Rate
- **BPSK**: Binary Phase Shift Keying
- **CA** : Conditional Access
- **CDM** : Code Division Multiplexing
- **C/I** : Carrier to Interference
- **DMB** : Digital Multimedia Broadcasting
- **EN** : European Standard
- **ES** : Elementary Stream
- **ETSI**: European Telecommunications Standards Institute
- **MPEG**: Moving Picture Experts Group
- **PN** : Pseudo-random Noise
- **PS** : Pilot Symbol
- **QPSK**: Quadrature Phase Shift Keying
- **RS** : Reed-Solomon
- **SI** : Service Information
- **TDM** : Time Division Multiplexing
- **TS** : Transport Stream

1. Safety Precautions

1-1. Repair Precaution

Before attempting any repair or detailed tuning, shield the device from RF noise or static electricity discharges.

Use only demagnetized tools that are specifically designed for small electronic repairs, as most electronic parts are sensitive to electromagnetic forces.

Use only high quality screwdrivers when servicing products. Low quality screwdrivers can easily damage the heads of screws.

Use only conductor wire of the properly gauge and insulation for low resistance, because of the low margin of error of most testing equipment.

We recommend 22-gauge twisted copper wire.

Hand-soldering is not recommended, because printed circuit boards (PCBs) can be easily damaged, even with relatively low heat. Never use a soldering iron with a power rating of more than 100 watts and use only lead-free solder with a melting point below 250°C (482°F).

Prior to disassembling the battery charger for repair, ensure that the AC power is disconnected. Always use the replacement parts that are registered in the SEC system. Third-party replacement parts may not function properly.

1. Safety Precautions

1-2. ESD(Electrostatically Sensitive Devices) Precaution

Many semiconductors and ESDs in electronic devices are particularly sensitive to static discharge and can be easily damaged by it. We recommend protecting these components with conductive anti-static bags when you store or transport them.

Always use an anti-static strap or wristband and remove electrostatic buildup or dissipate static electricity from your body before repairing ESDs.

Ensure that soldering irons have AC adapter with ground wires and that the ground wires are properly connected.

Use only desoldering tools with plastic tips to prevent static discharge.

Properly shield the work environment from accidental electrostatic discharge before opening packages containing ESDs.

The potential for static electricity discharge may be increased in low humidity environments, such as air-conditioned rooms. Increase the airflow to the working area to decrease the chance of accidental static electricity discharges.

6. Level 1 Repair

6-1. S/W installation

6-1-1. Required items in order to install S/W

- Installation program: Downloader Program ([Odin3 v3.12.5.exe](#))
- Mobile Phone
- Data Cable
- Mobile device specific S/W: Binary files

※ Settings

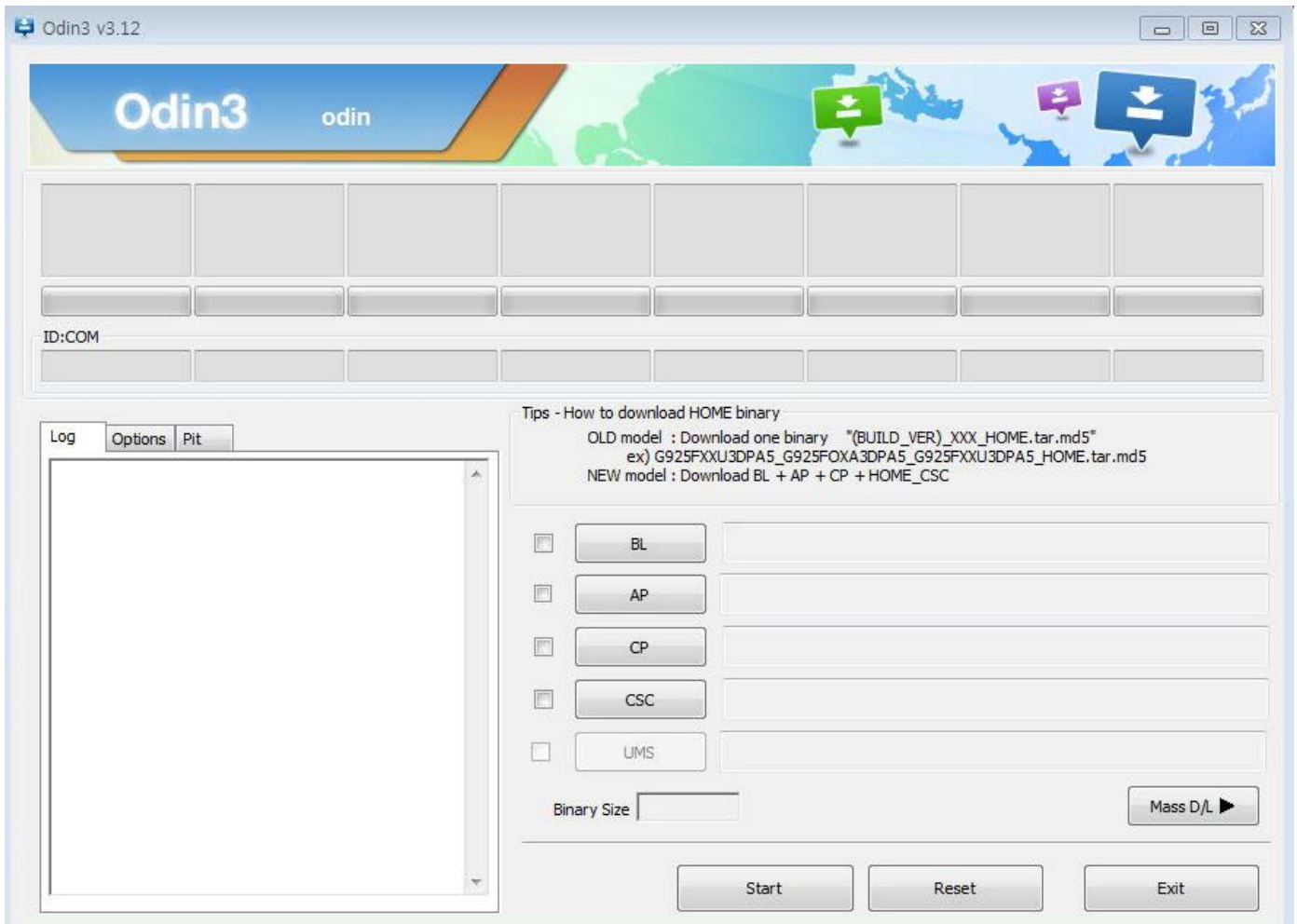


Data Cable : GH39-01710D

6. Level 1 Repair

6-1-2. S/W Installation Program (Downloader program)

- Open up the S/W Installation Program by executing the "**Odin3 v3.12.5.exe**"

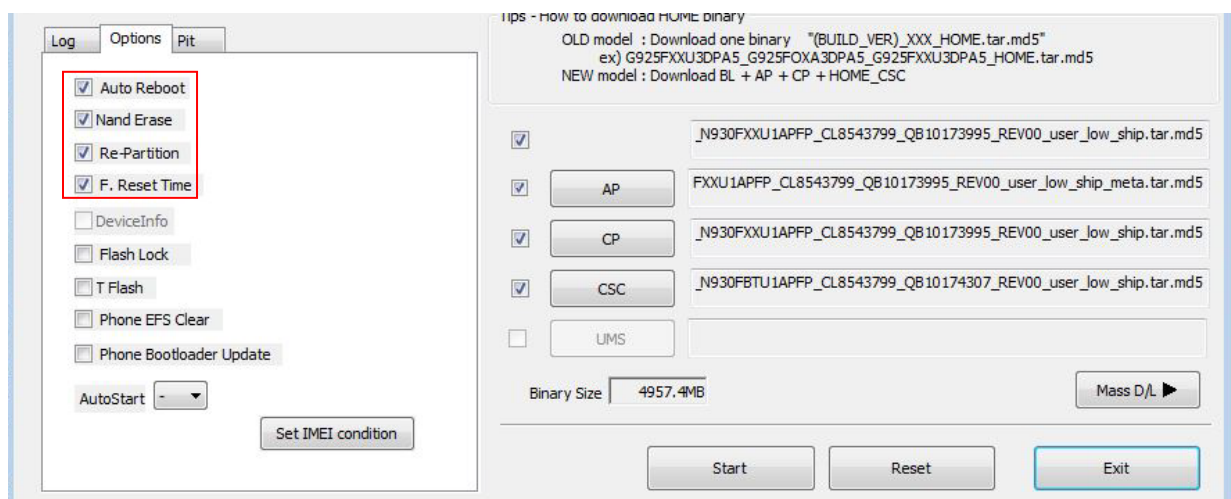
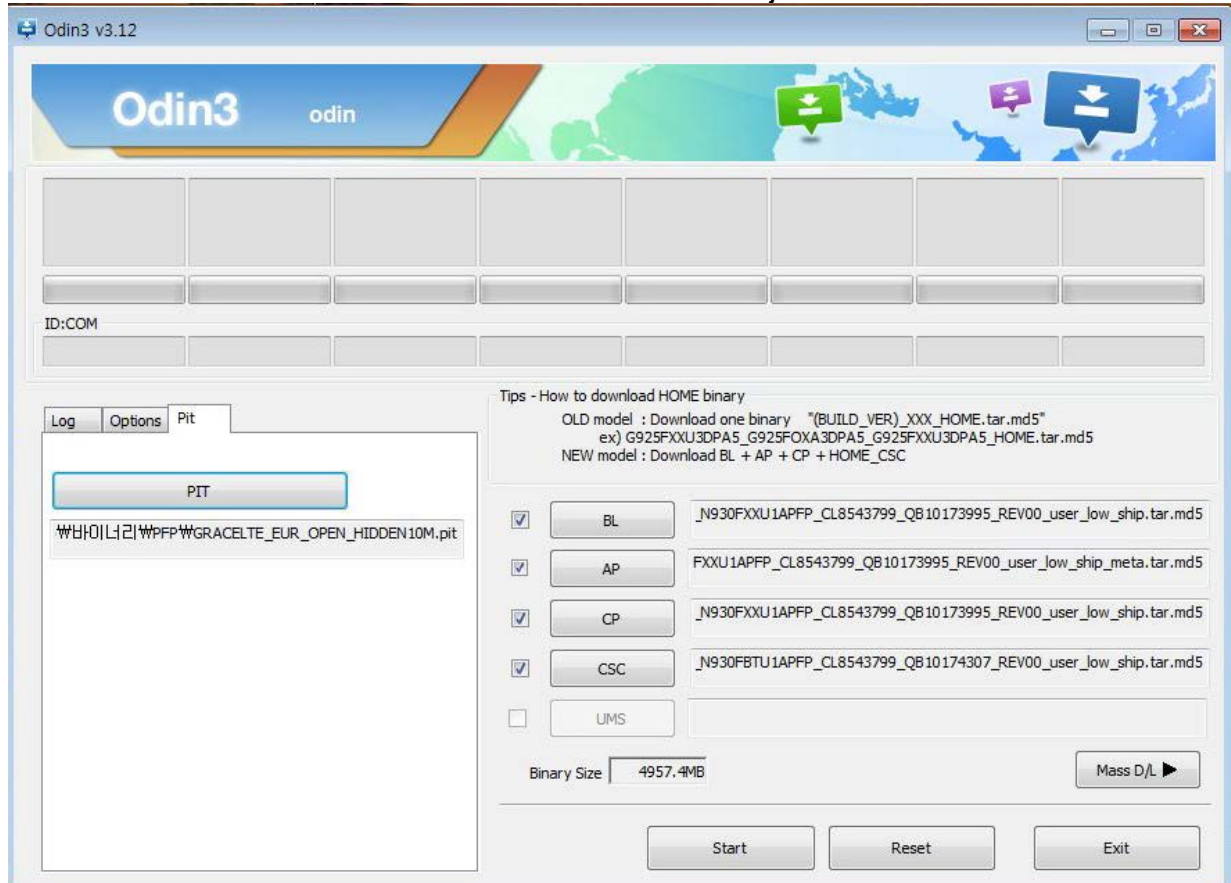


6. Level 1 Repair

1. Enable the check mark by click on the following options,

- Check Auto Reboot, Re-Partition, and F. Reset Time-
- Check PIT
- Check Nand Erase All
- Check BL, AP, CP, and CSC Files

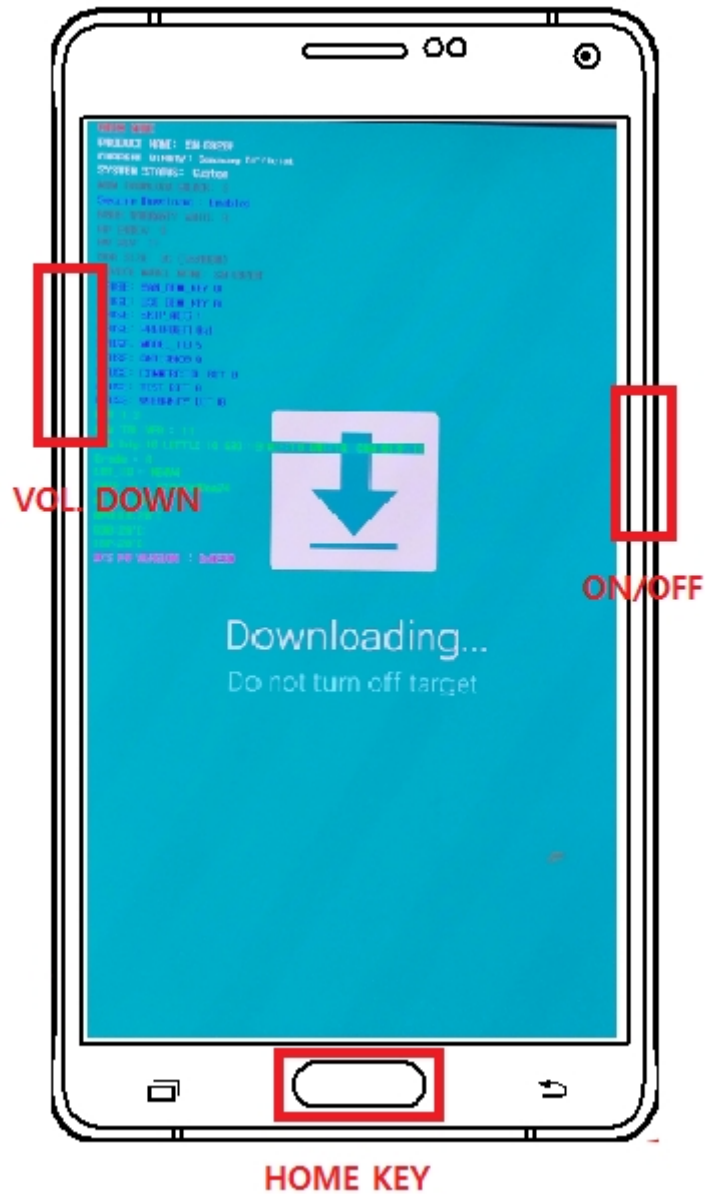
* Note : "Odin v3.12 or above" checks MD5 checksum just after file selection.



6. Level 1 Repair

2. Enter into Download Mode

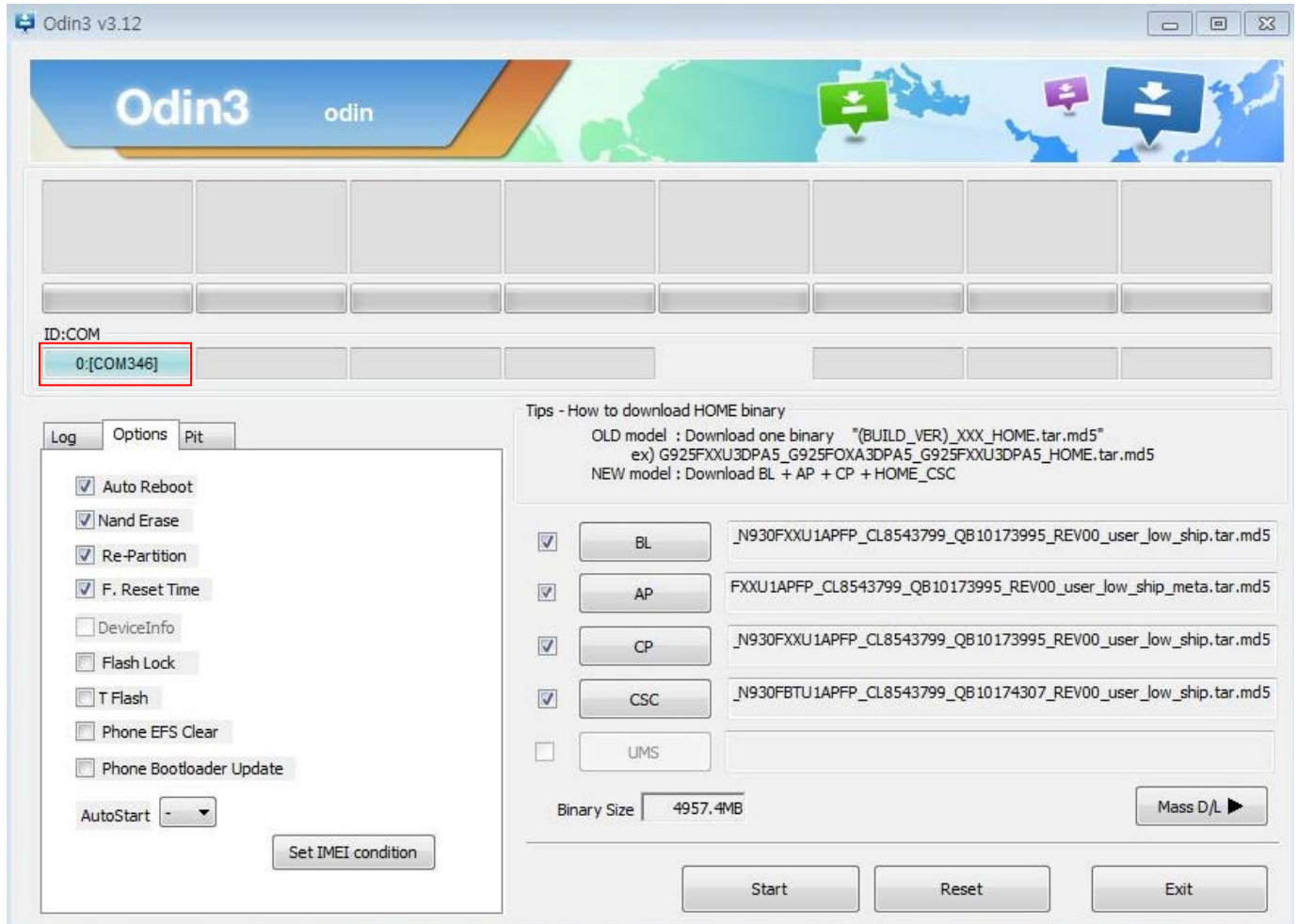
- Enter into Download Mode by pressing Home button, Volume Down button and Power On/Off Button simultaneously followed by pressing Volume up button as a direction of the phone.



6. Level 1 Repair

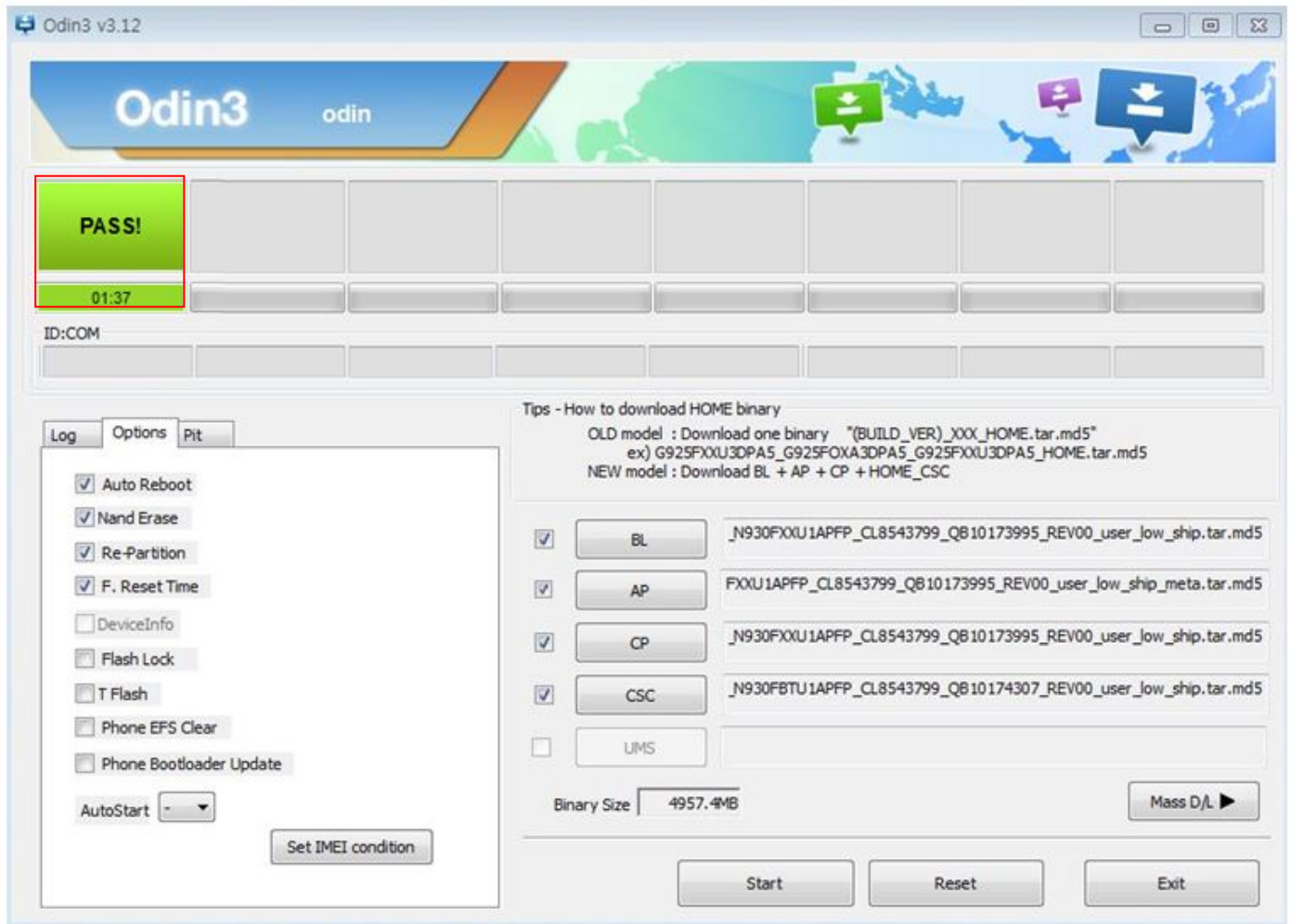
3. Connect the device to PC via Data Cable.

Make sure that the one of communication ports [ID:COM] box is highlighted in sky blue. The device is now connected with the PC and ready to download the binary files in it.



6. Level 1 Repair

4. Start downloading the binary files into the device by clicking Start button on the screen. The green colored "PASS!" sign will appear on the upper-left box if the binary files have been successfully downloaded into the device.



5. Disconnect the device from the Data cable.
6. Once the device boots up, you can check the version of the binary file or name by pressing the following code in sequence; ***#1234#**

You can perform Factory Reset by Settings → Accounts → Backup and reset

※ **Caution. Never disconnect during the S/W downloading.**

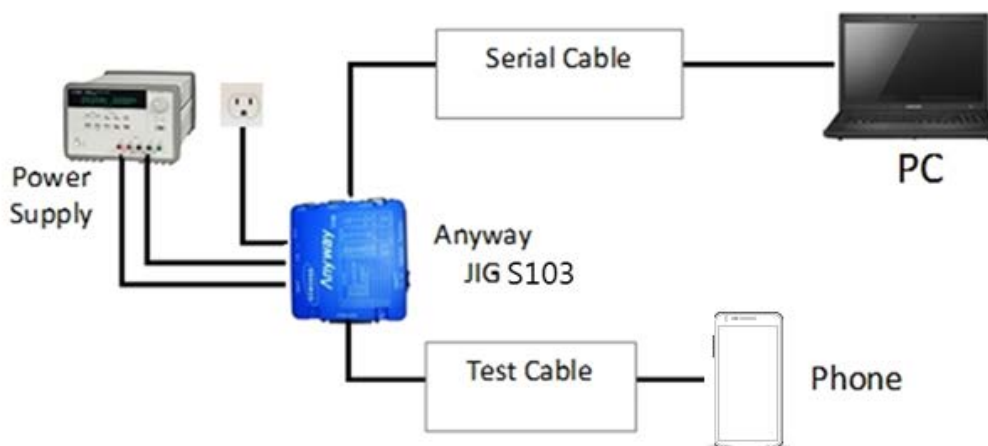
6. Level 1 Repair

6-2 IMEI writing

6-2-1 Preparation

- New IMEI writing Program has been released.
- Supported Model : Models which CAB files are uploaded on HHPsvc INI File category, instead of ini file.
- Refer to below IMEI writing procedure.

- H/W



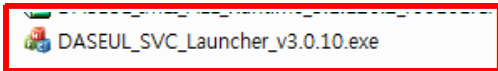
- S/W

① Library Install	To use Daseul, library files should be installed. Refer to SVC Bulletin “(11-82) Daseul (New IMEI writing Program) Library Install guide_rev1.0”
② Launcher	DASEUL_SVC_Launcher_v3_0_25 or higher -Uploaded on HHPsvc Notice
③ Runtime File	1. DASEUL_Runtime_Ver_3.1.299.0.CAB or higher -Uploaded on HHPsvc Notice 2. Make 'ModelName' folder at the same position with launcher & Runtime file.
④ Model File	Copy Model File under the 'Model Name' folder

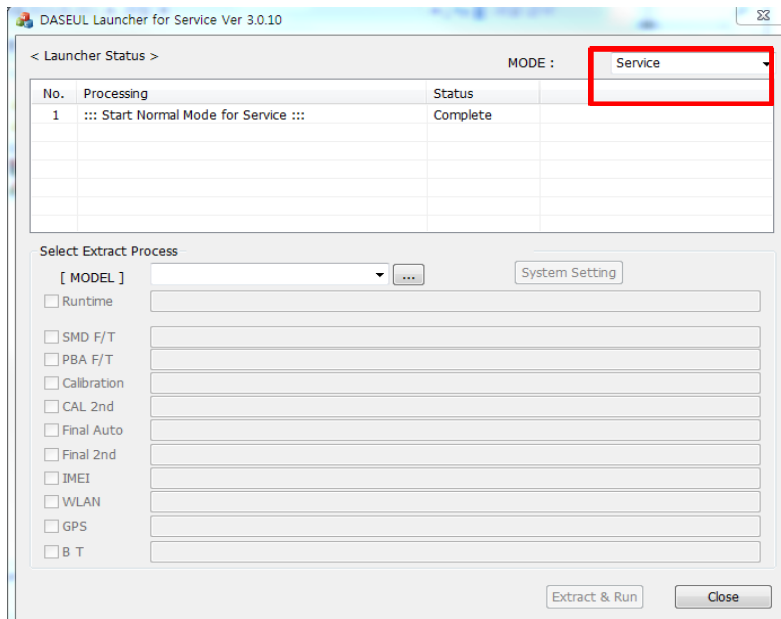
6. Level 1 Repair

6-2-2 IMEI writing Process

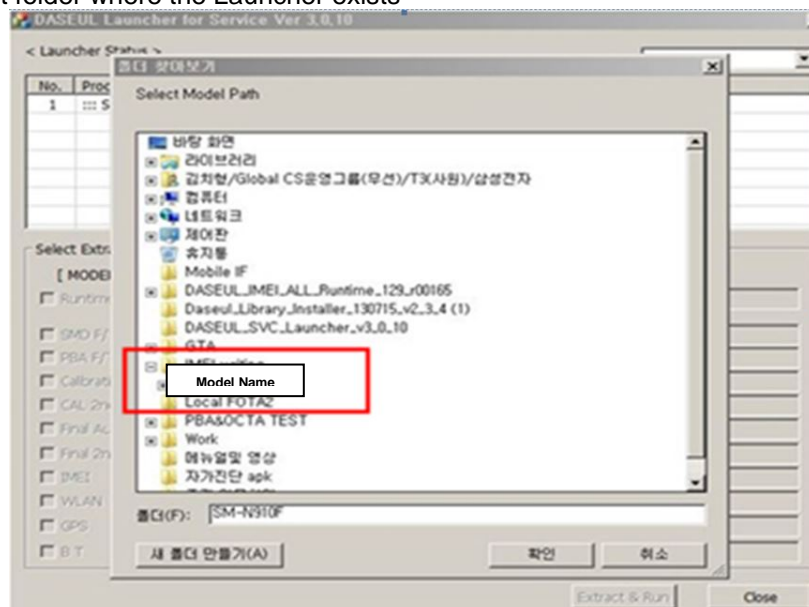
1. Run DASEUL_SVC_Launcher_v3.0.10.exe



2. Select Service Mode

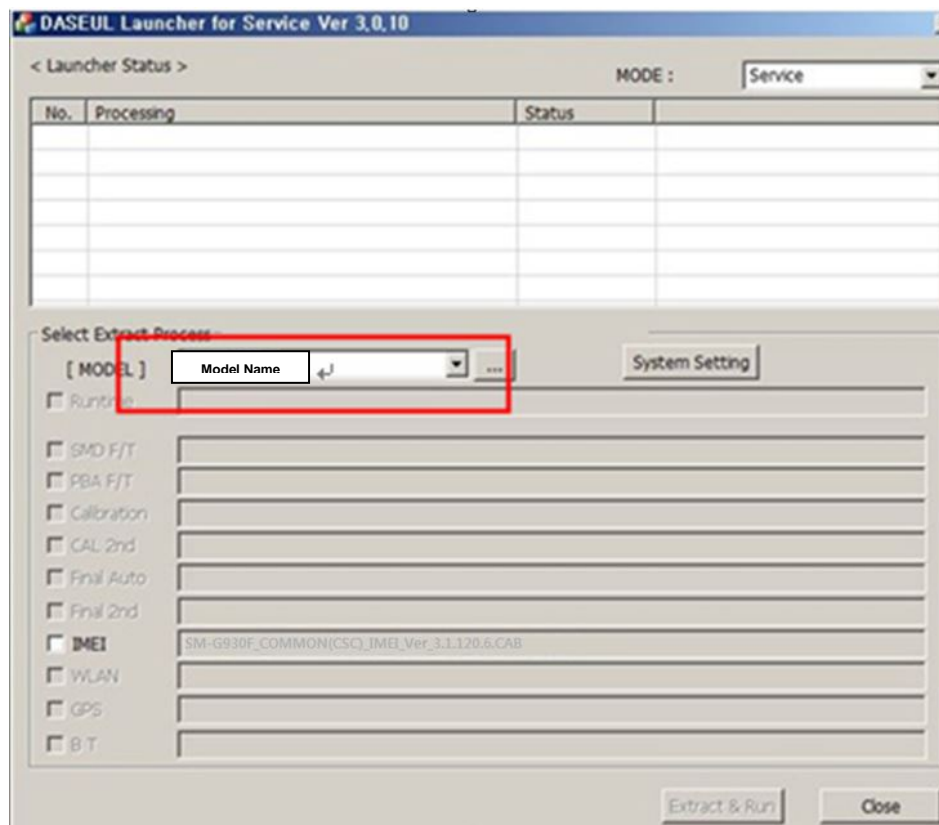


3. Click [MODEL] and Select folder where the Launcher exists



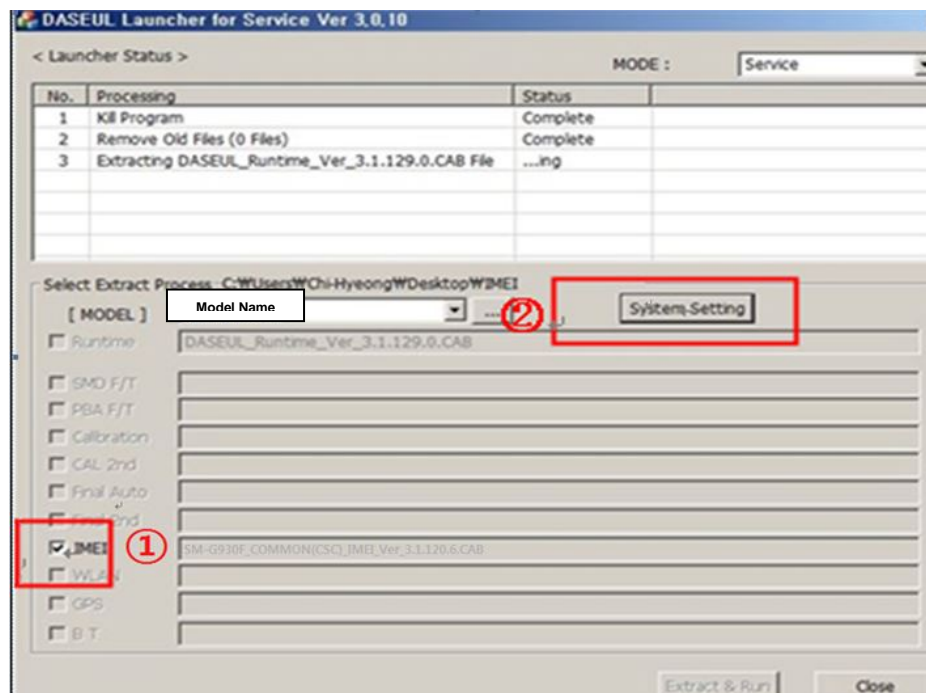
6. Level 1 Repair

4. Select Model



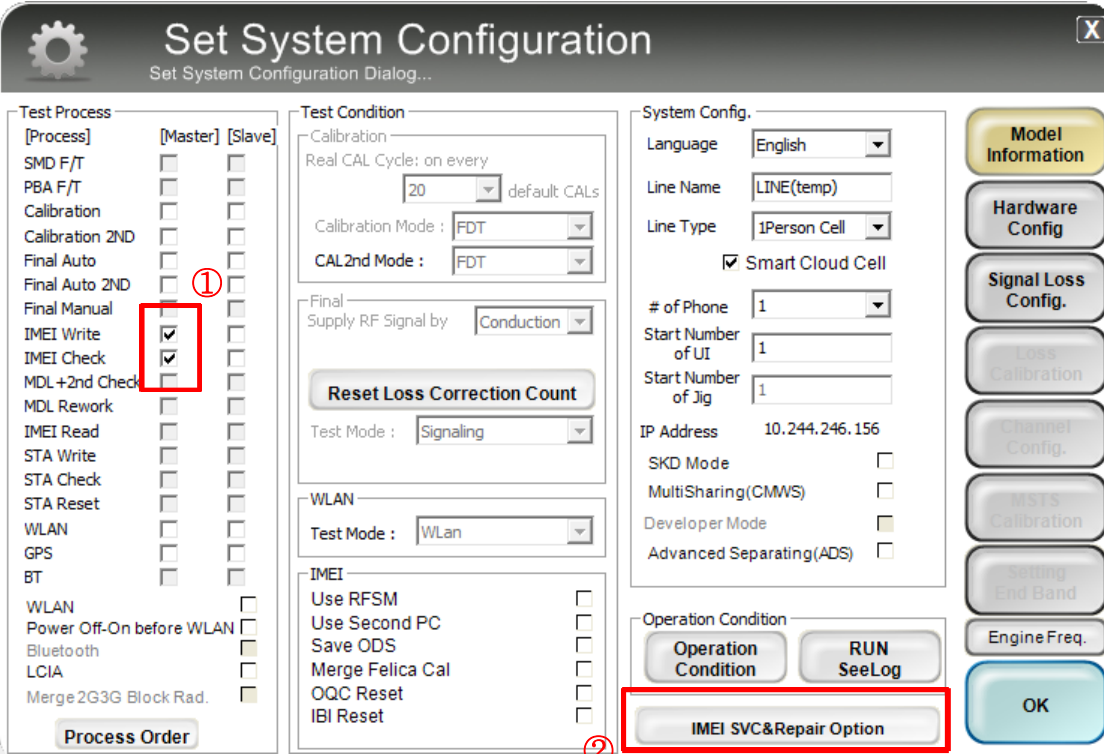
5. Check IMEI and click System Setting

※ Once you setup the setting, you don't have to do it again, unless there is change. From second run of the IMEI program, check IMEI and click Extract & Run.



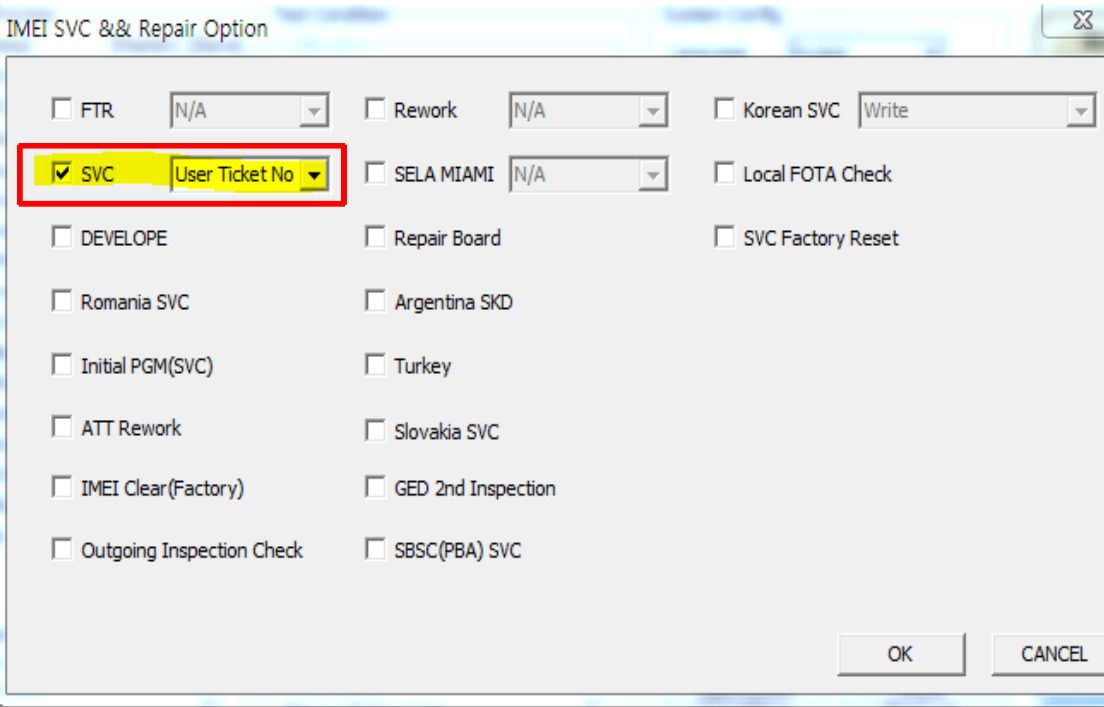
6. Level 1 Repair

6. Check IMEI Write / IMEI Check and click IMEI SVC & Repair Option.



The image shows the 'Set System Configuration' dialog box. In the 'Test Process' section, the 'IMEI Write' and 'IMEI Check' checkboxes are checked and highlighted with a red box and a circled '1'. In the 'Test Condition' section, the 'IMEI' sub-section is expanded, and the 'IMEI SVC & Repair Option' button is highlighted with a red box and a circled '2'. The 'System Config.' section contains various settings like Language, Line Name, Line Type, and Smart Cloud Cell. The 'Operation Condition' section has buttons for 'Operation Condition', 'RUN SeeLog', and 'IMEI SVC & Repair Option'. The 'Model Information' section on the right has buttons for 'Model Information', 'Hardware Config', 'Signal Loss Config.', 'Loss Calibration', 'Channel Config.', 'MSTS Calibration', 'Setting End Band', and 'Engine Freq.'. The 'OK' button is at the bottom right.

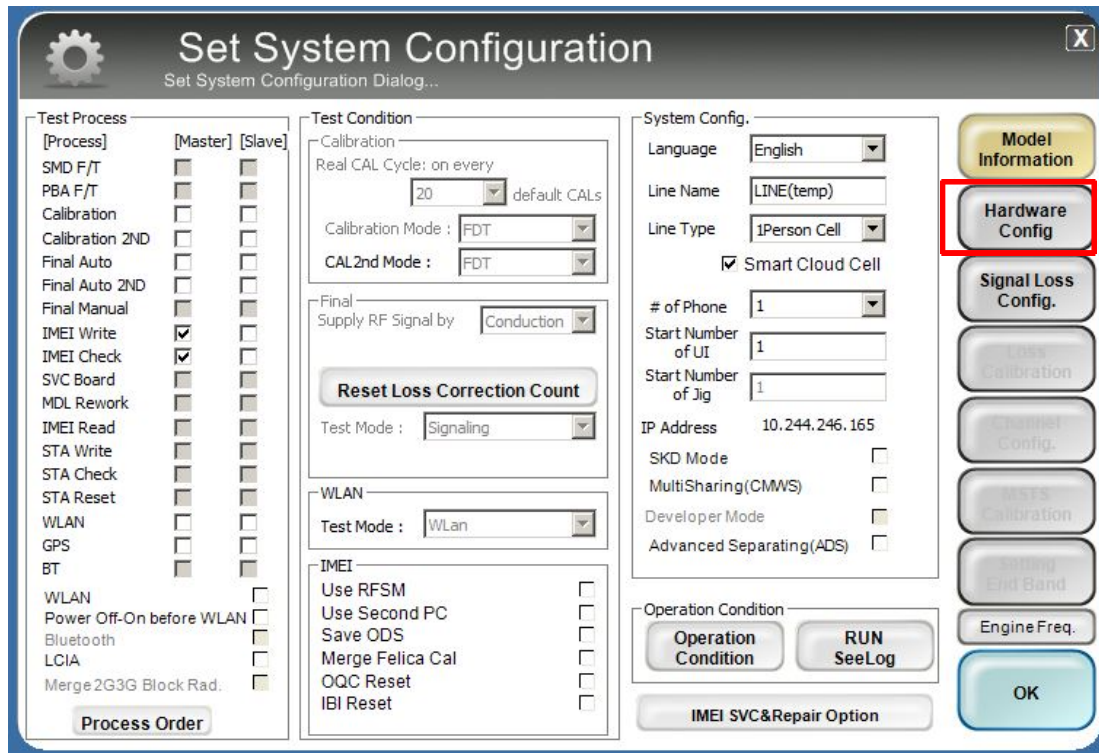
7. Check SVC , User Ticket No and click OK



The image shows the 'IMEI SVC && Repair Option' dialog box. The 'SVC' checkbox is checked and highlighted with a red box. The 'User Ticket No' dropdown menu is also highlighted with a red box. Other options include 'FTR', 'Rework', 'Korean SVC', 'SELA MIAMI', 'Local FOTA Check', 'DEVELOPE', 'Repair Board', 'SVC Factory Reset', 'Romania SVC', 'Argentina SKD', 'Initial PGM(SVC)', 'Turkey', 'ATT Rework', 'Slovakia SVC', 'IMEI Clear(Factory)', 'GED 2nd Inspection', 'Outgoing Inspection Check', and 'SBSC(PBA) SVC'. The 'OK' and 'CANCEL' buttons are at the bottom right.

6. Level 1 Repair

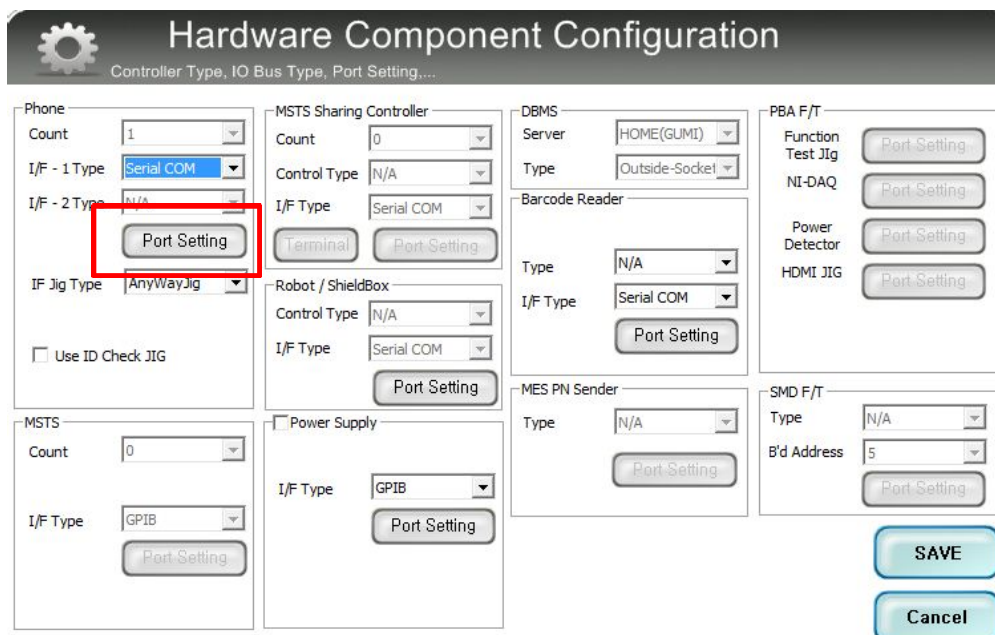
8. Click Hardware Config



The 'Set System Configuration' dialog box is shown. It has a title bar with a gear icon and the text 'Set System Configuration Dialog...'. The dialog is divided into several sections:

- Test Process:** A list of test processes with checkboxes for [Process], [Master], and [Slave]. Processes include SMD F/T, PBA F/T, Calibration, Calibration 2ND, Final Auto, Final Auto 2ND, Final Manual, IMEI Write, IMEI Check, SVC Board, MDL Rework, IMEI Read, STA Write, STA Check, STA Reset, WLAN, GPS, BT, WLAN, Power Off-On before WLAN, Bluetooth, LCIA, and Merge2G3G Block Rad.
- Test Condition:** Includes 'Calibration' (Real CAL Cycle: on every 20, default: CALs), 'Calibration Mode' (FDT), 'CAL2nd Mode' (FDT), 'Final Supply RF Signal by' (Conduction), 'Reset Loss Correction Count' button, 'Test Mode' (Signaling), 'WLAN Test Mode' (Wlan), and 'IMEI' options (Use RFSM, Use Second PC, Save ODS, Merge Felica Cal, OQC Reset, IBI Reset).
- System Config.:** Includes 'Language' (English), 'Line Name' (LINE(temp)), 'Line Type' (1Person Cell), 'Smart Cloud Cell' (checked), '# of Phone' (1), 'Start Number of UI' (1), 'Start Number of Jig' (1), 'IP Address' (10.244.246.165), 'SKD Mode', 'MultiSharing(CMWS)', 'Developer Mode', and 'Advanced Separating(ADS)'.
- Operation Condition:** Includes 'Operation Condition' and 'RUN SeeLog' buttons.
- Model Information:** A vertical stack of buttons: 'Model Information' (highlighted with a red box), 'Hardware Config' (highlighted with a red box), 'Signal Loss Config.', 'Loss Calibration', 'Channel Config.', 'MSTC Calibration', 'Setting End Band', 'Engine Freq.', and 'OK'.

9. Click Port Setting

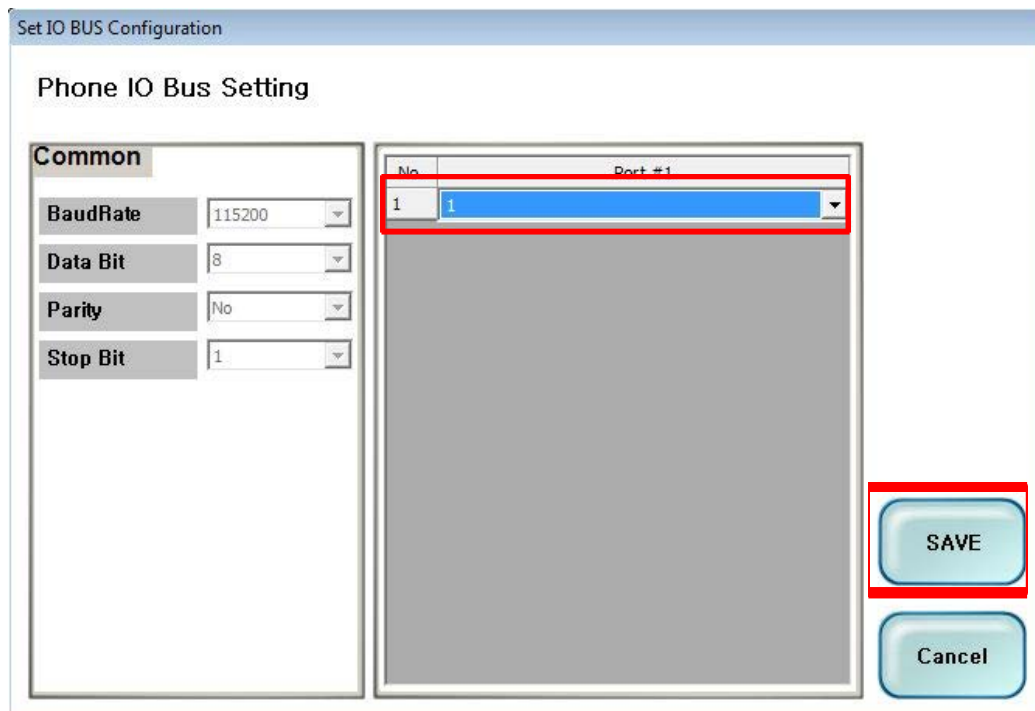


The 'Hardware Component Configuration' dialog box is shown. It has a title bar with a gear icon and the text 'Controller Type, IO Bus Type, Port Setting,...'. The dialog is divided into several sections:

- Phone:** Includes 'Count' (1), 'I/F - 1 Type' (Serial COM), 'I/F - 2 Type' (N/A), 'I/F Jig Type' (AnyWayJig), and 'Use ID Check JIG' (unchecked).
- MSTS:** Includes 'Count' (0) and 'I/F Type' (GPIB).
- MSTS Sharing Controller:** Includes 'Count' (0), 'Control Type' (N/A), 'I/F Type' (Serial COM), and 'Terminal' button.
- Robot / ShieldBox:** Includes 'Control Type' (N/A), 'I/F Type' (Serial COM), and 'Port Setting' button.
- Power Supply:** Includes 'I/F Type' (GPIB) and 'Port Setting' button.
- DBMS:** Includes 'Server' (HOME(GUMI)), 'Type' (Outside-Socket), and 'Barcode Reader' (Type: N/A, I/F Type: Serial COM, Port Setting button).
- MES PN Sender:** Includes 'Type' (N/A) and 'Port Setting' button.
- PBA F/T:** Includes 'Function Test Jig' (Port Setting button), 'NI-DAQ' (Port Setting button), 'Power Detector' (Port Setting button), and 'HDMI JIG' (Port Setting button).
- SMD F/T:** Includes 'Type' (N/A), 'B'd Address' (5), and 'Port Setting' button.
- Buttons:** 'SAVE' and 'Cancel' buttons at the bottom right.

6. Level 1 Repair

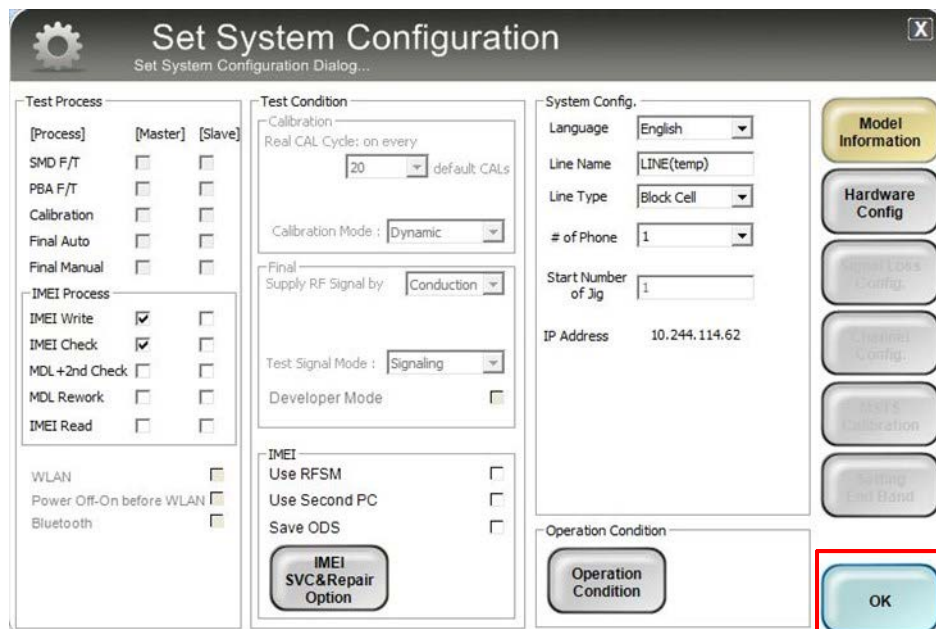
10. Select Port Number and SAVE



The image shows a 'Set IO BUS Configuration' dialog box with the title 'Phone IO Bus Setting'. It has two main sections. The left section, titled 'Common', contains four settings: 'BaudRate' set to 115200, 'Data Bit' set to 8, 'Parity' set to No, and 'Stop Bit' set to 1. The right section is a table with two columns: 'No.' and 'Port #1'. The first row of the table is highlighted with a red box, showing '1' in the 'No.' column and '1' in the 'Port #1' column. Below the table, there are two buttons: 'SAVE' and 'Cancel'. The 'SAVE' button is highlighted with a red box.

No.	Port #1
1	1

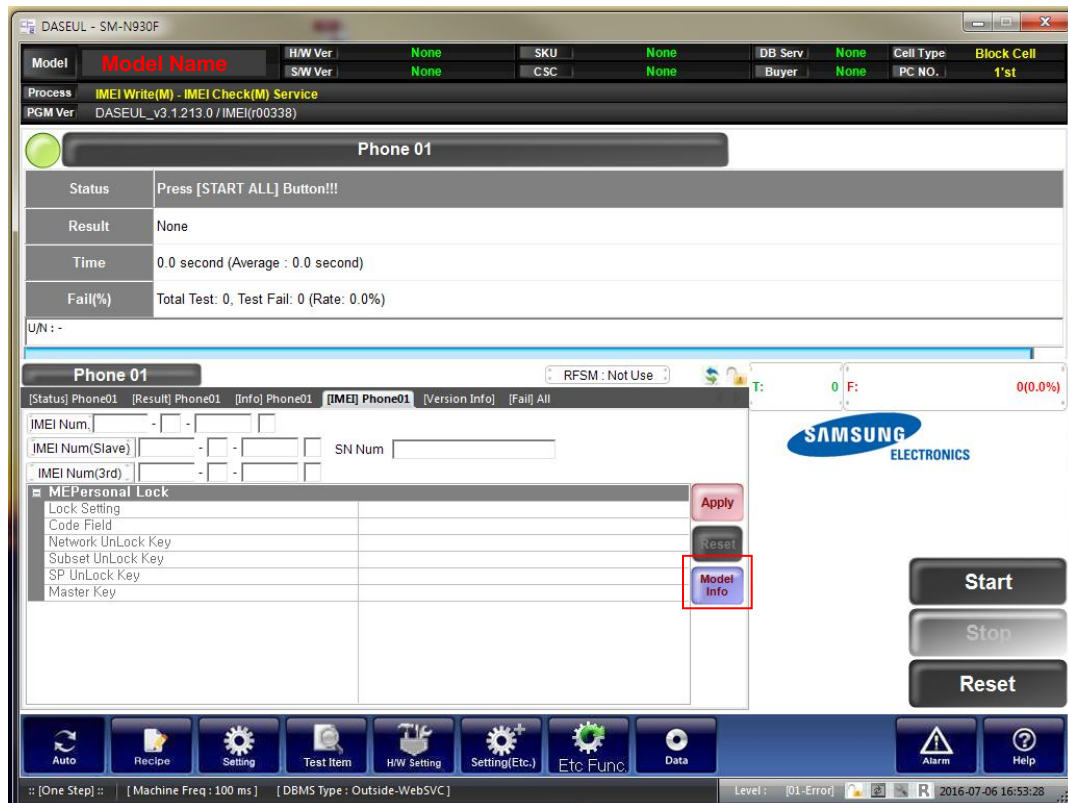
11. Click OK to proceed



The image shows a 'Set System Configuration' dialog box with the title 'Set System Configuration Dialog...'. It has several sections. The 'Test Process' section on the left has checkboxes for [Process], [Master], and [Slave] for SMD F/T, PBA F/T, Calibration, Final Auto, and Final Manual. Below this is the 'IMEI Process' section with checkboxes for IMEI Write, IMEI Check (checked), MDL +2nd Check, MDL Rework, and IMEI Read. At the bottom left are checkboxes for WLAN, Power Off-On before WLAN, and Bluetooth. The 'Test Condition' section in the middle has a 'Calibration' section with 'Real CAL Cycle: on every' set to 20 and 'default CALs'. Below this is 'Calibration Mode' set to Dynamic. The 'Final' section has 'Supply RF Signal by' set to Conduction. The 'Test Signal Mode' is set to Signaling. There is also a 'Developer Mode' checkbox. The 'IMEI' section has checkboxes for 'Use RFSM', 'Use Second PC', and 'Save ODS'. The 'System Config.' section on the right has 'Language' set to English, 'Line Name' set to LINE(temp), 'Line Type' set to Block Cell, '# of Phone' set to 1, 'Start Number of Jig' set to 1, and 'IP Address' set to 10.244.114.62. On the far right is a vertical stack of buttons: 'Model Information', 'Hardware Config', 'Signal Loss Config', 'Channel Config', 'Factory Calibration', and 'Setting End Band'. At the bottom right, there are two buttons: 'IMEI SVC&Repair Option' and 'Operation Condition'. The 'OK' button is highlighted with a red box.

6. Level 1 Repair

12. Click Model Info and OK when pop-up shows



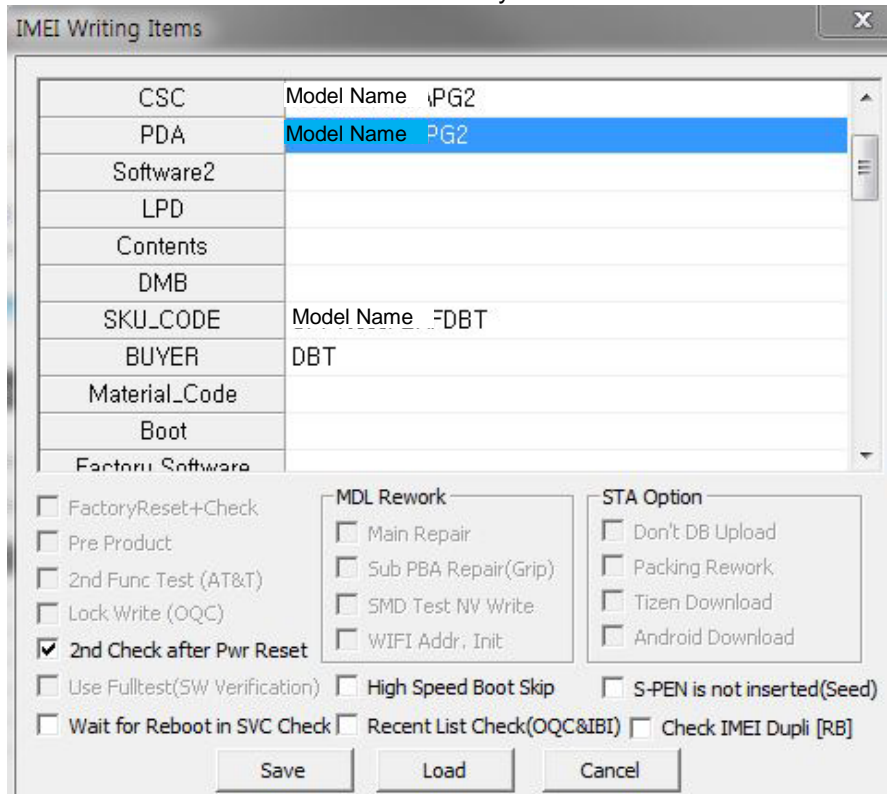
13. Click OK



6. Level 1 Repair

14. Input SKU_CODE and BUYER, then click Save button.

※ Refer to HHPsvc→IMEI Review to check SKU Code and buyer



The 'IMEI Writing Items' dialog box contains a table with the following items and values:

Item	Value
CSC	Model Name PG2
PDA	Model Name PG2
Software2	
LPD	
Contents	
DMB	
SKU_CODE	Model Name DBT
BUYER	DBT
Material_Code	
Boot	
Factory Software	

Below the table are several checkboxes:

- ☐ FactoryReset+Check
- ☐ Pre Product
- ☐ 2nd Func Test (AT&T)
- ☐ Lock Write (OQC)
- ☒ 2nd Check after Pwr Reset
- ☐ Use Fulltest(SW Verification)
- ☐ Wait for Reboot in SVC Check

MDL Rework section:

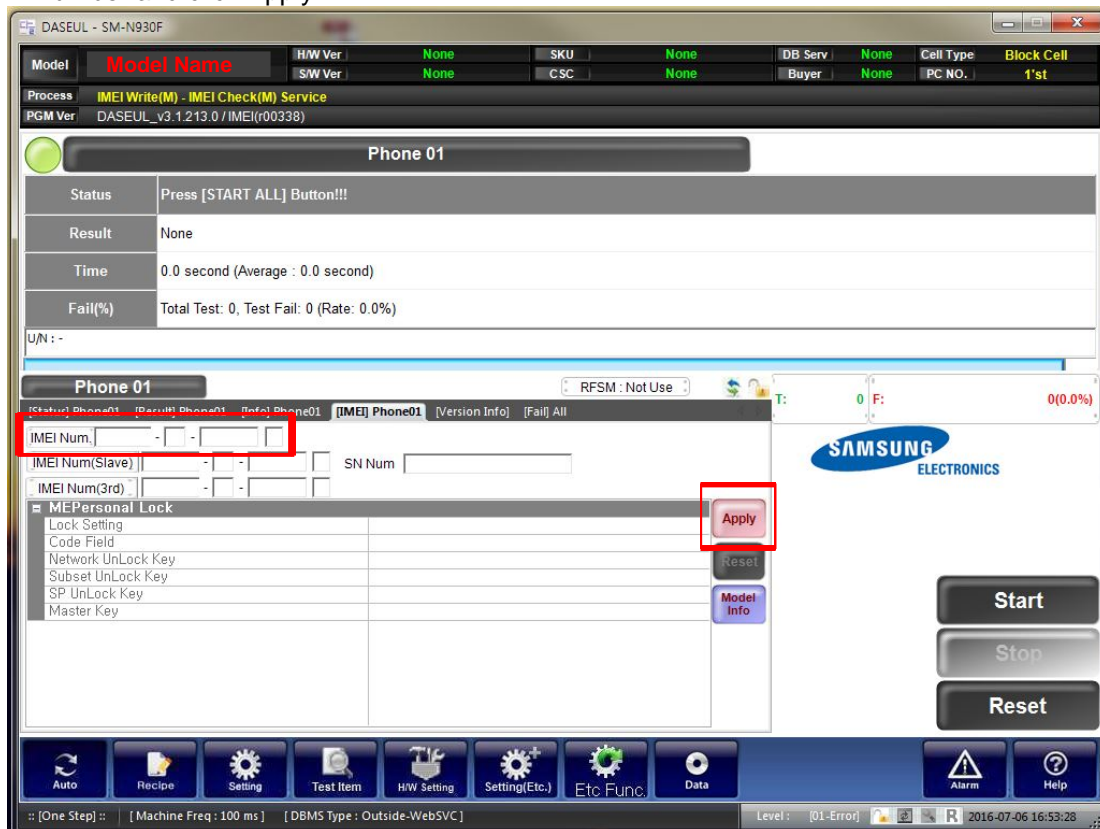
- ☐ Main Repair
- ☐ Sub PBA Repair(Grip)
- ☐ SMD Test NV Write
- ☐ WIFI Addr. Init
- ☐ High Speed Boot Skip
- ☐ Recent List Check(OQC&IBI)

STA Option section:

- ☐ Don't DB Upload
- ☐ Packing Rework
- ☐ Tizen Download
- ☐ Android Download
- ☐ S-PEN is not inserted(Seed)
- ☐ Check IMEI Dupli [RB]

Buttons: Save, Load, Cancel

15. Input IMEI Number and click Apply



The main interface shows the 'Phone 01' section with the following status:

- Status: Press [START ALL] Button!!!
- Result: None
- Time: 0.0 second (Average : 0.0 second)
- Fail(%): Total Test: 0, Test Fail: 0 (Rate: 0.0%)

Below this is the 'Phone 01' section with a red box highlighting the 'IMEI Num.' field. The 'Apply' button is also highlighted with a red box.

Buttons: Start, Stop, Reset

Bottom bar: Auto, Recipe, Setting, Test Item, H/W Setting, Setting(Etc.), Etc Func, Data, Alarm, Help

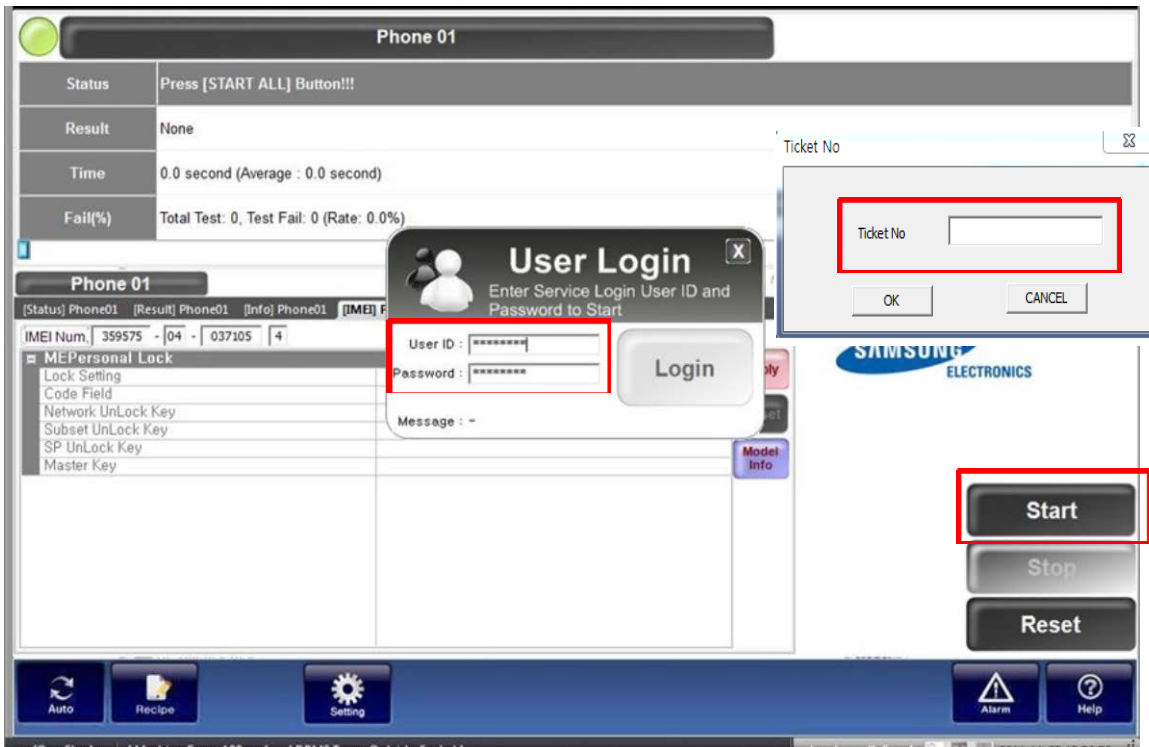
Footer: [One Step] [Machine Freq: 100 ms] [DBMS Type: Outside-WebSVC] Level: [01-Error] 2016-07-06 16:53:28

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6. Level 1 Repair

16. ① Click Start, and input IMEI writing ID and Password → ② input Ticket No

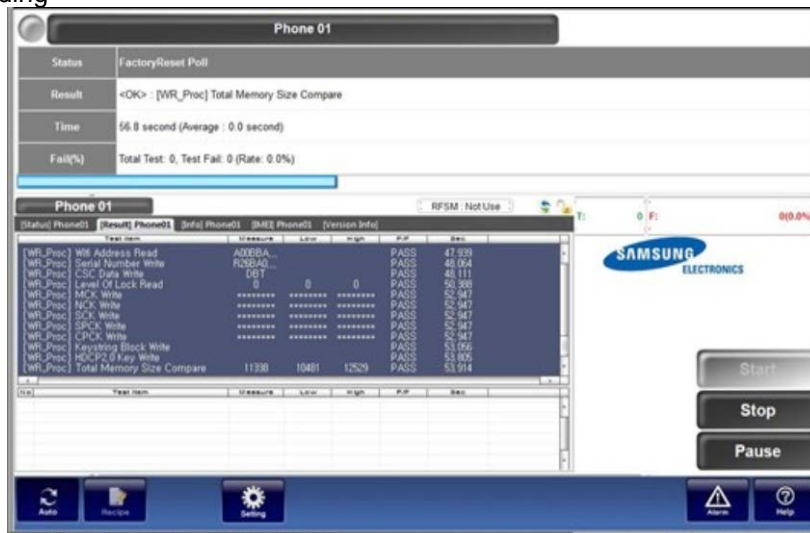


17. Connect the phone to Anyway JIG

※ When you connect the phone, the phone should be turned off.

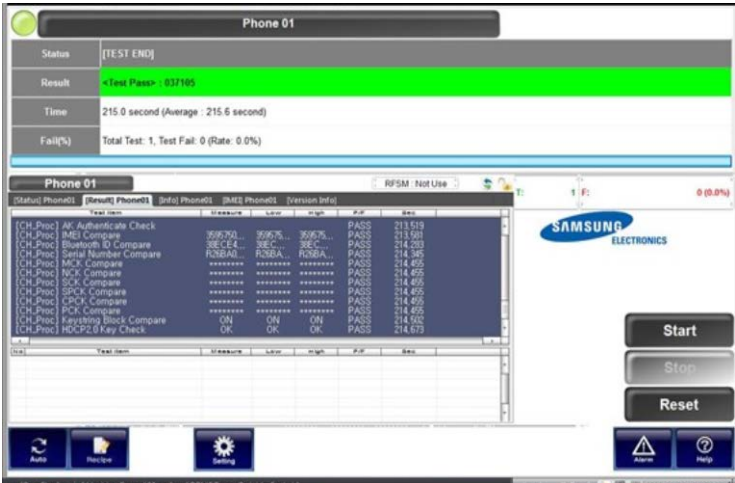
After connecting the phone, the phone will be booted automatically.

18. IMEI Writing Proceeding



6. Level 1 Repair

19. IMEI Writing Success



6. Level 1 Repair

6-3. RF Calibration





6-3-1. Required items in order to calibrate RF

- Installation program: RF Calibration Program
 - Daseul_Launcher_vx.x.xx.exe
 - Daseul_CAL_ALL_Runtime_x.x.xxx.x.CAB
 - Model File ([Model Name_OPEN_CALIBRATION_Ver_3.1.298.3.CAB](#))

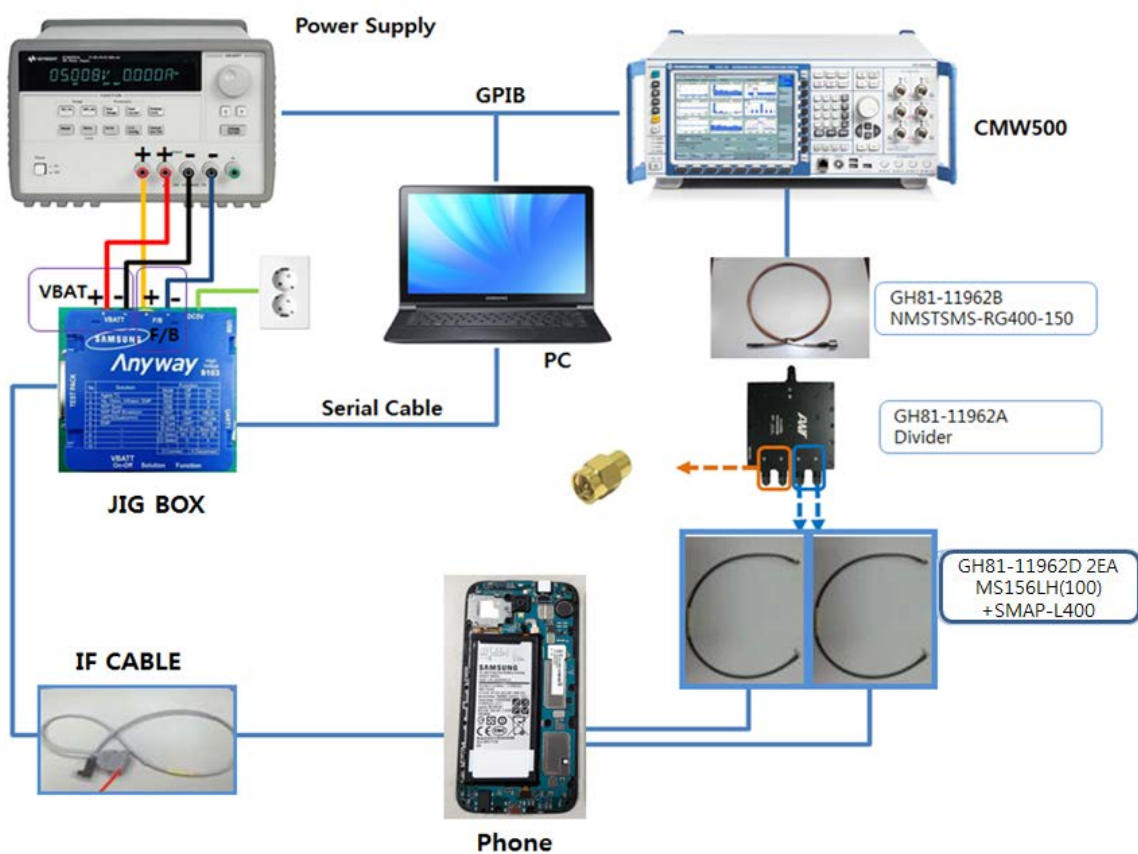
※ It is required to use the latest program.

- Mobile Phone
- R&S CMW500
- E3632A Power Supply
- GPIB Cable (2ea)
- JIG BOX (GH81-12520B)
- IF Cable (GH81-10952A)
- Adapter (GH81-11888K)
- UART Serial Cable
- RF Cable (GH81-11962D, 2EA)
- 50Ω terminator (GH81-11962E, 2EA)

• Table of test cables

RF Cable (Manual)	GH81-11962D		
	1.35T Long 		
4 Port Divider	GH81-11962A	GH81-11962B	GH81-11962E
	Use / No use 	Divider Cable 	50Ω terminator 




6. Level 1 Repair



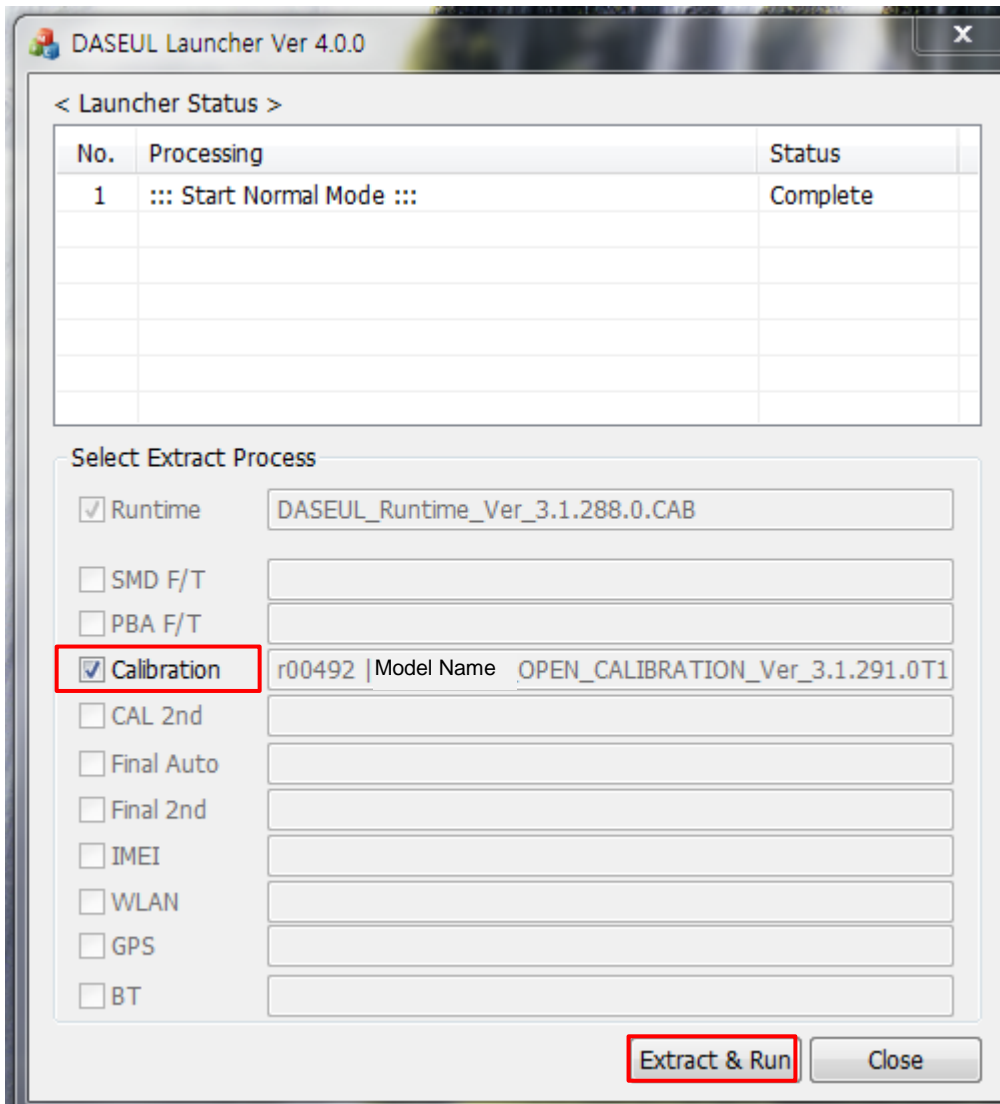
6. Level 1 Repair

6-3-2. RF Calibration Program

1. Run the RF Calibration Program Launcher, '[DASEUL_Launcher_vx.x.xx.exe](#)'.

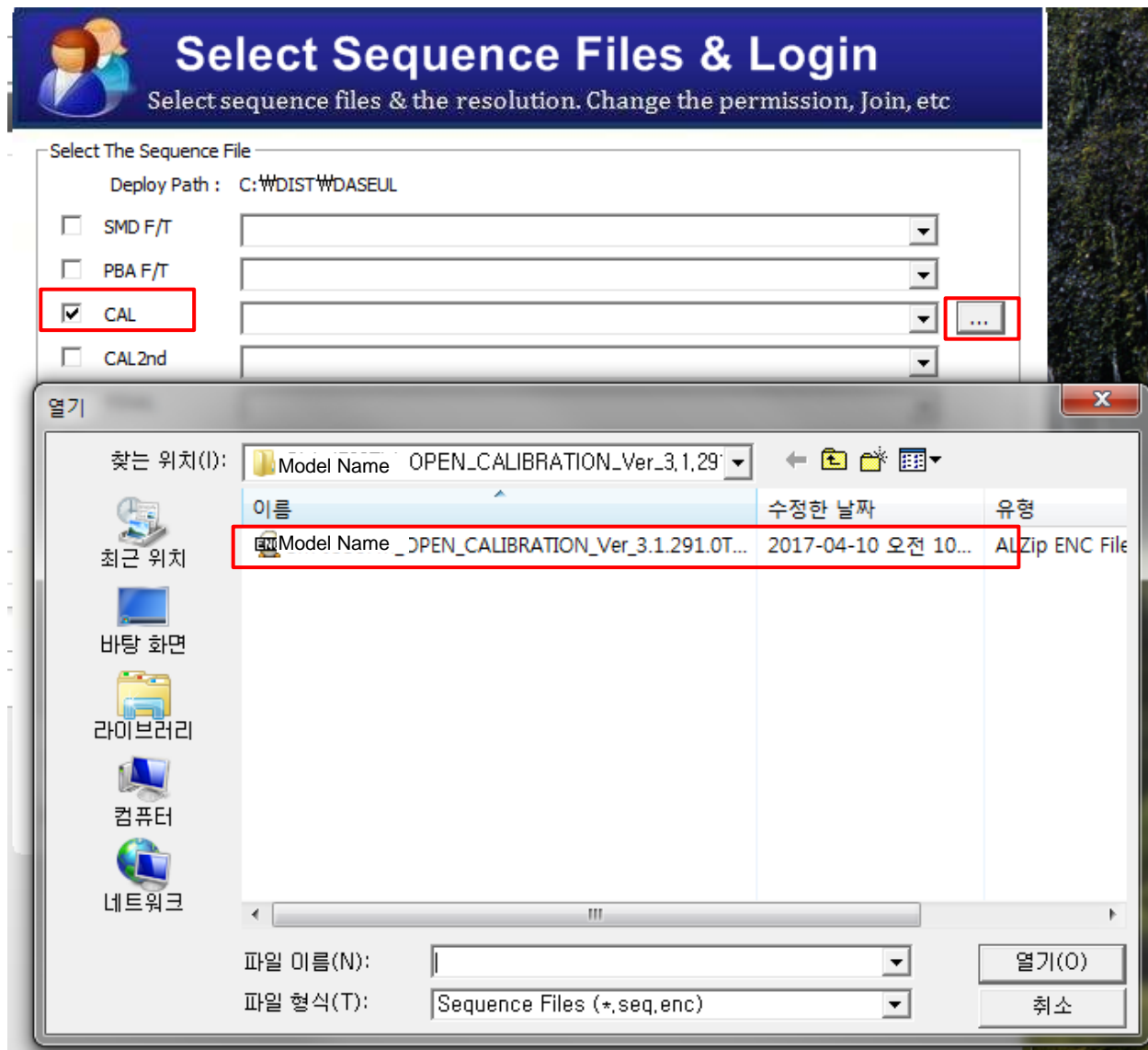
 DASEUL_CAL_ALL_Runtime_3.1.257.0_r00455.CAB
 DASEUL_Launcher_v4.0.0.exe
 SM-J530FM_OPEN_CALIBRATION_Ver_3.1.257.1.CAB

2. Check the '[Calibration](#)' menu, and select '[Extract & Run](#)'.



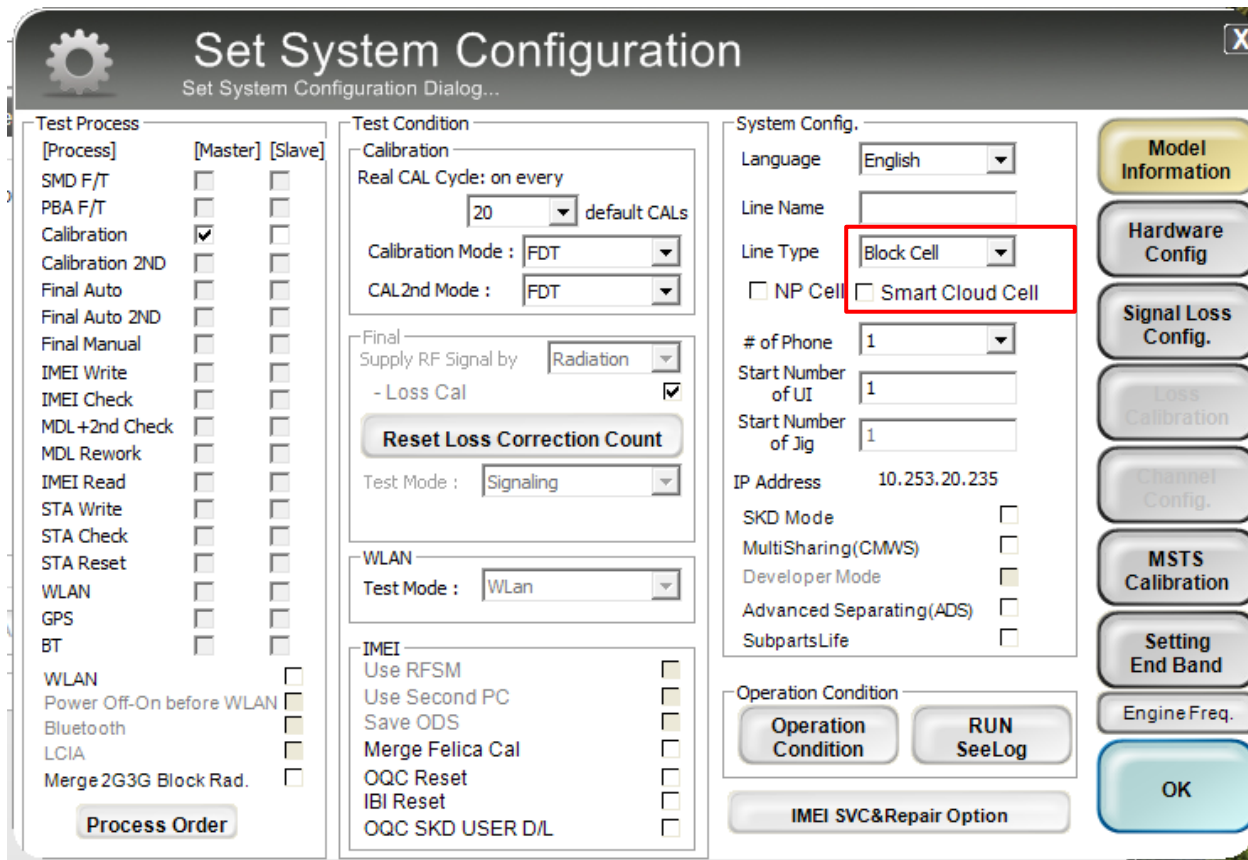
6. Level 1 Repair

3. Check the 'CAL' and open the [model file](#), then select 'Start' button.



6. Level 1 Repair

4. Change the Line Type to 'Block Cell' and disable 'Smart Cloud Cell'.



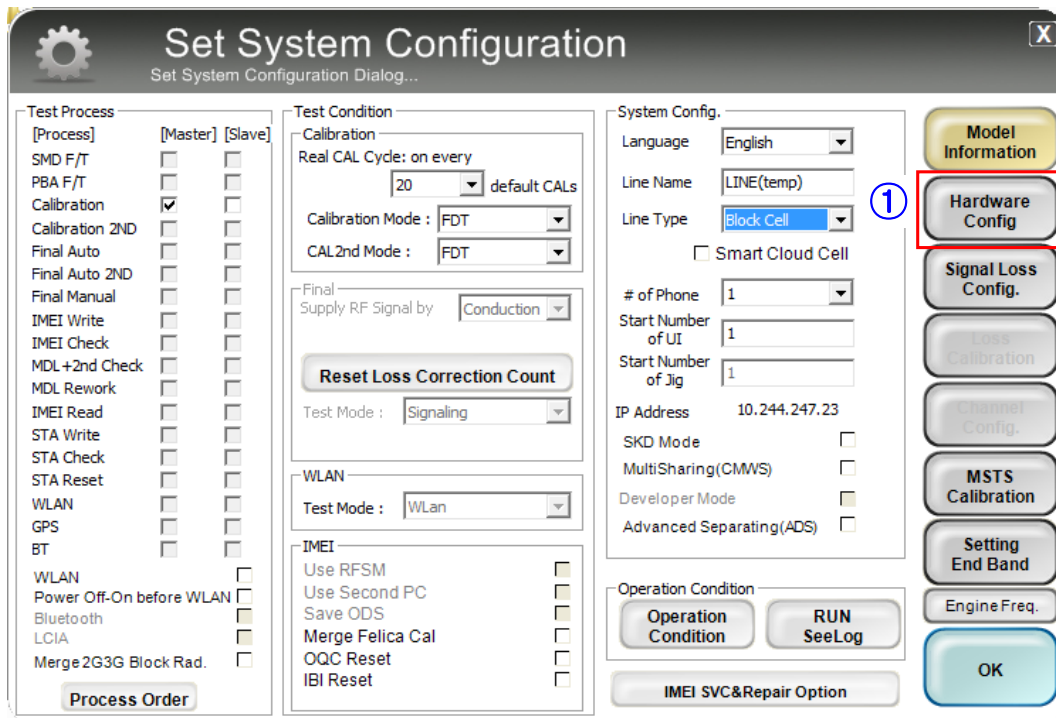
The image shows a 'Set System Configuration' dialog box with a title bar and a close button (X). The dialog is divided into several sections:

- Test Process:** A list of test processes with checkboxes for [Process], [Master], and [Slave]. The 'Calibration' process is checked under [Master].
- Test Condition:**
 - Calibration:** Real CAL Cycle: on every 20 default CALs. Calibration Mode: FDT. CAL2nd Mode: FDT.
 - Final:** Supply RF Signal by: Radiation. - Loss Cal: checked. A 'Reset Loss Correction Count' button is present. Test Mode: Signaling.
 - WLAN:** Test Mode: WLAN.
 - IMEI:** Use RFSM, Use Second PC, Save ODS, Merge Felica Cal, OQC Reset, IBI Reset, OQC SKD USER D/L.
- System Config.:**
 - Language: English.
 - Line Name: (empty).
 - Line Type: Block Cell (highlighted with a red box).
 - ☐ NP Cell. ☐ Smart Cloud Cell (disabled).
 - # of Phone: 1.
 - Start Number of UI: 1.
 - Start Number of Jig: 1.
 - IP Address: 10.253.20.235.
 - SKD Mode, MultiSharing(CMWS), Developer Mode, Advanced Separating(ADS), SubpartsLife: all unchecked.
- Operation Condition:** Operation Condition button, RUN SeeLog button, and IMEI SVC&Repair Option button.

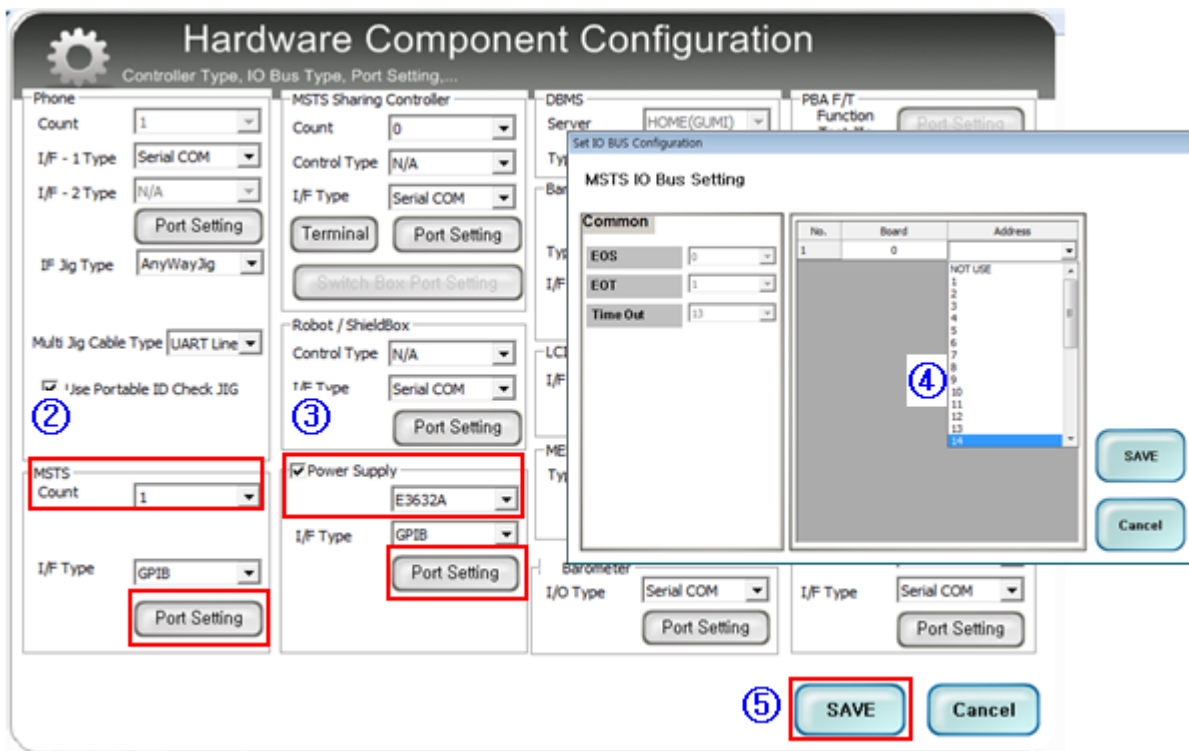
On the right side of the dialog, there is a vertical stack of buttons: Model Information, Hardware Config, Signal Loss Config., Loss Calibration, Channel Config., MSTs Calibration, Setting End Band, Engine Freq., and OK.

6. Level 1 Repair

5. Set the GPIB address of MSTS(CMW500) and Power Supply(E3632A) to enter 'Hardware Config' and 'Save'. (Check the GPIB address of equipments in advance)



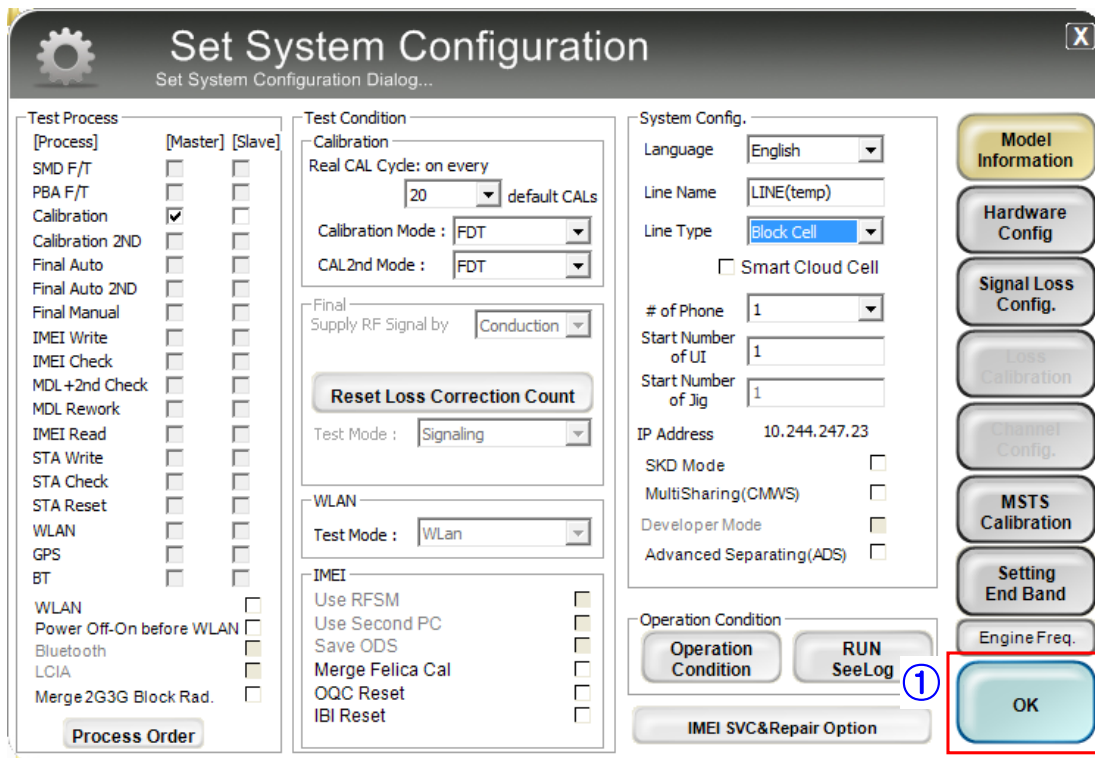
The 'Set System Configuration' dialog box is shown. It has a title bar with a gear icon and a close button. The main area is divided into several sections: 'Test Process' on the left with checkboxes for [Process], [Master], and [Slave]; 'Test Condition' in the top middle with fields for 'Real CAL Cycle' (20), 'Calibration Mode' (FDT), and 'CAL2nd Mode' (FDT); 'System Config.' on the right with fields for 'Language' (English), 'Line Name' (LINE(temp)), 'Line Type' (Block Cell), and 'Smart Cloud Cell' (unchecked); and a vertical stack of buttons on the far right including 'Model Information', 'Hardware Config' (highlighted with a red box and a circled 1), 'Signal Loss Config.', 'Loss Calibration', 'Channel Config.', 'MSTS Calibration', 'Setting End Band', 'Engine Freq.', and 'OK'. There are also buttons for 'Reset Loss Correction Count', 'Test Mode' (Signaling), 'WLAN Test Mode' (WLAN), 'IMEI' settings, 'Operation Condition', 'RUN SeeLog', and 'IMEI SVC&Repair Option'.



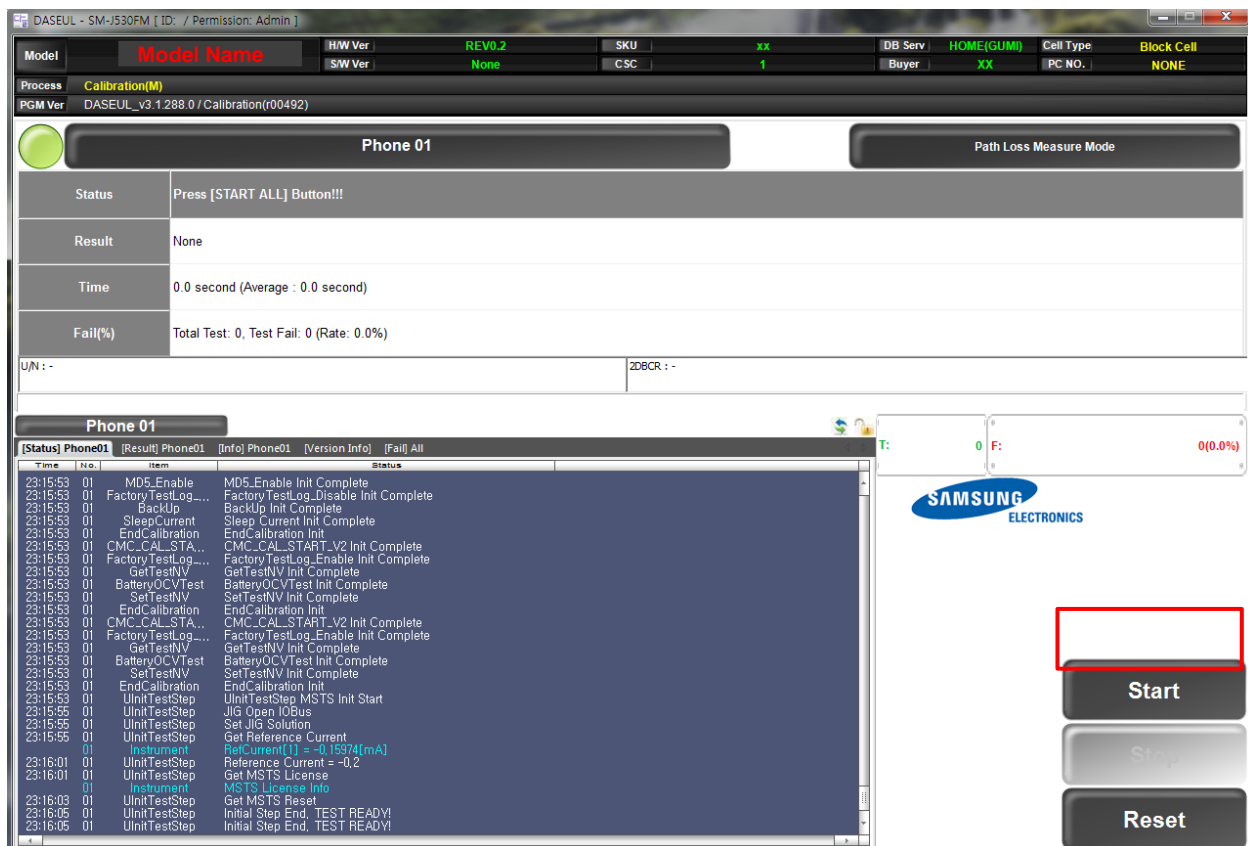
The 'Hardware Component Configuration' dialog box is shown. It has a title bar with a gear icon and a close button. The main area is divided into several sections: 'Phone' on the left with fields for 'Count' (1), 'I/F - 1 Type' (Serial COM), 'I/F - 2 Type' (N/A), and 'IF Jig Type' (AnyWayJig); 'MSTS Sharing Controller' in the top middle with fields for 'Count' (0), 'Control Type' (N/A), 'I/F Type' (Serial COM), and 'Terminal'; 'Robot / ShieldBox' in the bottom middle with fields for 'Control Type' (N/A), 'I/F Type' (Serial COM), and 'Port Setting'; and a 'MSTS IO Bus Setting' sub-dialog box on the right with fields for 'EOS' (2), 'EOT' (1), and 'Time Out' (13). The 'MSTS IO Bus Setting' sub-dialog box has a table with columns 'No.', 'Board', and 'Address'. The table has 14 rows, with row 14 highlighted. A circled 4 is next to row 14. The 'MSTS IO Bus Setting' sub-dialog box has 'SAVE' and 'Cancel' buttons. The main dialog box has a 'SAVE' button highlighted with a red box and a circled 5. There are also buttons for 'Port Setting' and 'Switch Box Port Setting'.

6. Level 1 Repair

6. Press 'OK' to start RF Calibration after completing all settings.



The 'Set System Configuration' dialog box is shown with various tabs and settings. The 'Test Process' tab is active, showing a list of test items with checkboxes for [Process], [Master], and [Slave]. The 'Test Condition' tab is also visible, showing settings for Calibration, Final Supply RF Signal, and WLAN. The 'System Config.' tab is active, showing settings for Language, Line Name, Line Type, Smart Cloud Cell, # of Phone, Start Number of UI, Start Number of Jig, IP Address, SKD Mode, MultiSharing(CMWS), Developer Mode, and Advanced Separating(ADS). The 'Operation Condition' tab is also visible, showing settings for Operation Condition, RUN, SeeLog, and IMEI SVC&Repair Option. The 'OK' button is highlighted with a red box and a circled '1'.



The 'DASEUL - SM-J530FM' interface is shown, displaying various system information and test results. The 'Model Name' is 'Model Name', 'H/W Ver' is 'REV0.2', 'SKU' is 'xx', 'DB Serv' is 'HOME(GUM)', 'Cell Type' is 'Block Cell', 'Process' is 'Calibration(M)', 'PGM Ver' is 'DASEUL_v3.1.288.0 / Calibration(r00492)', 'Buyer' is 'XX', and 'PC NO.' is 'NONE'. The 'Phone 01' section shows 'Status: Press [START ALL] Button!!!', 'Result: None', 'Time: 0.0 second (Average : 0.0 second)', and 'Fail(%): Total Test: 0, Test Fail: 0 (Rate: 0.0%)'. The 'Phone 01' section also shows a list of test items and their status. The 'Start' button is highlighted with a red box.